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# 6GHz High Linearity I/Q Demodulator with Wideband IF Amplifier

## FEATURES

- 300MHz to 6GHz Operating Frequency
- Wide IF Bandwidth: DC to 1GHz (–1dB Bandwidth)
- High Mixer IIP3: 30dBm at 1.9GHz
- High Total OIP3: 40dBm at 1.9GHz
- High Total OIP2: 74dBm at 1.9GHz
- User Adjustable OIP2 to 80dBm
- User Adjustable Image Rejection to 60dB
- User Adjustable DC Offset Null
- Serial Interface
- Power Conversion Gain: 7.7dB at 1.9GHz
- 31dB RF Attenuator with 1dB Step Size
- RF Switch with 40dB Isolation at 1.9GHz
- Single-Ended RF Inputs with On-Chip Transformer
- IF Amplifier Gain Adjustable in 8 Steps
- Operating Temperature Range (T<sub>C</sub>): –40°C to 105°C
- 32-Lead 5mm × 5mm QFN Package

## APPLICATIONS

- 4G and 5G Base Station Receivers
- Wideband DPD Receivers
- Point-To-Point Broadband Radios
- High Linearity Direct Conversion I/Q Receivers
- Image Rejection Receivers

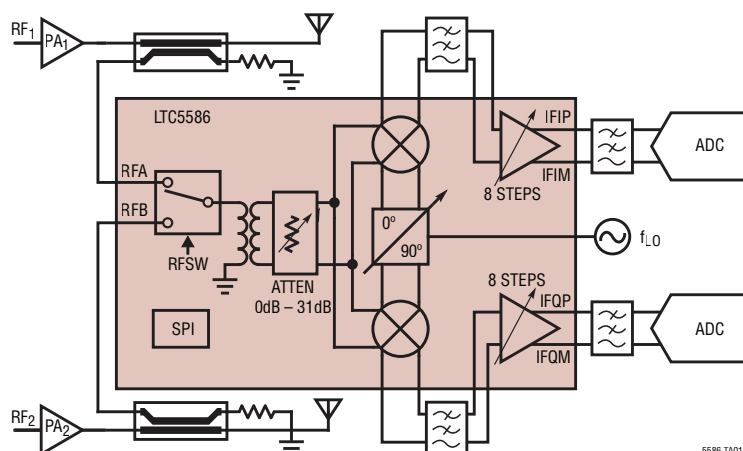
## DESCRIPTION

The **LTC<sup>®</sup>5586** is a direct conversion quadrature demodulator optimized for high linearity zero-IF and low-IF receiver applications in the 300MHz to 6GHz frequency range. The very wide IF bandwidth of more than 1GHz makes the LTC5586 particularly suited for demodulation of very wide-band signals, especially in Digital Pre-Distortion (DPD) applications. The outstanding dynamic range of the LTC5586 makes the device suitable for demanding infrastructure direct conversion applications. Proprietary technology inside the LTC5586 provides the capability to optimize OIP2 to 80dBm, and achieve image rejection better than 60dB. The DC offset control function allows nulling of the DC offset at the A/D converter input, thereby optimizing the dynamic range of true zero-IF receivers that use DC coupled IF signal paths. The wide-band RF and LO input ports make it possible to cover all the major wireless infrastructure frequency bands using a single device. The IF outputs of the LTC5586 are designed to interface directly with most common A/D converter input interfaces. The high OIP3 and high conversion gain of the device eliminate the need for additional amplifiers in the IF signal path.

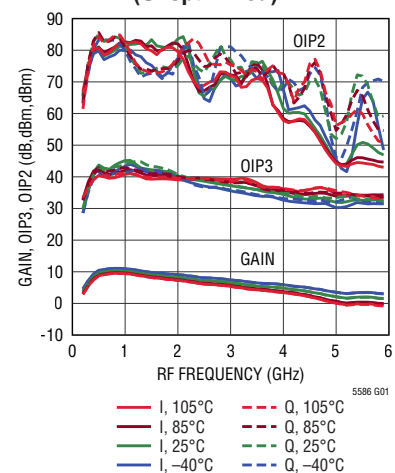
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## TYPICAL APPLICATION

Dual Band Transmitter with DPD Receiver



Gain, OIP3 and OIP2 vs Temperature (T<sub>C</sub>)  
(Unoptimized)



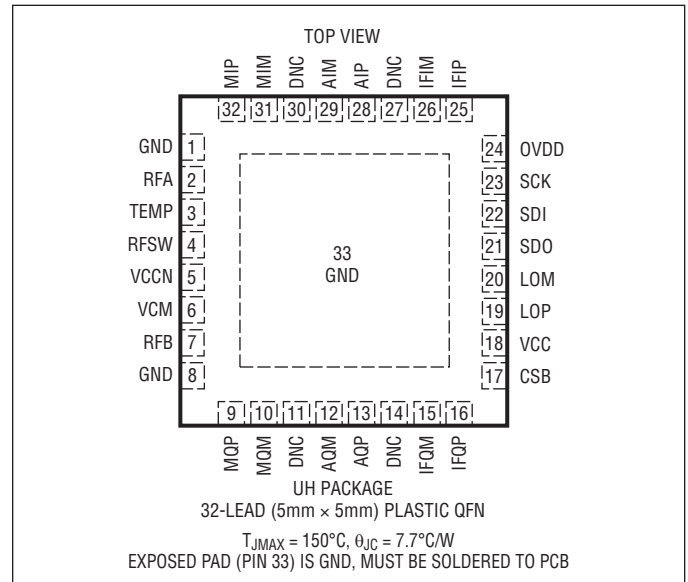


## ABSOLUTE MAXIMUM RATINGS

(Note 1)

VCC, VCCN Supply Voltage (Note 21) .....	-0.3V to 5.5V
OVDD, SDO Voltage (Note 18).....	-0.3V to 3.8V
RFA, RFB DC Voltage .....	1.5V to 2.0V
LOP, LOM DC Voltage .....	2.1V to 2.8V
IFIM, IFIP, IFQP, IFQM DC Voltage .....	-0.3V to 3.5V
AIM, AIP, AQM, AQP	
DC Voltage .....	$V_{CC} - 1.7V$ to $V_{CC} - 1.2V$
MIM, MIP, MQM, MQP	
DC Voltage .....	$V_{CC} - 1.7V$ to $V_{CC} - 1.2V$
Voltage on Any Other Pin .....	-0.3V to 5.5V
LOP, LOM, RFA, RFB Input Power (Note 17) .....	+20dBm
Output Short Circuit Duration (Notes 14, 17) ...	Indefinite
Maximum Junction Temperature ( $T_{JMAX}$ ) .....	150°C
Case Operating Temperature Range ( $T_C$ )	-40°C to 105°C
Storage Temperature Range .....	-65°C to 150°C

## PIN CONFIGURATION



## ORDER INFORMATION

<http://www.linear.com/product/LTC5586#orderinfo>

LEAD FREE FINISH	TAPE AND REEL	PART MARKING	PACKAGE DESCRIPTION	TEMPERATURE RANGE
LTC5586IUH#PBF	LTC5586IUH#TRPBF	5586	32-Lead (5mm x 5mm) Plastic QFN	-40°C to 105°C

Consult LTC Marketing for parts specified with wider operating temperature ranges.

For more information on lead free part marking, go to: <http://www.linear.com/leadfree/>

For more information on tape and reel specifications, go to: <http://www.linear.com/tapeandreeel/>. Some packages are available in 500 unit reels through designated sales channels with #TRMPBF suffix.

## ELECTRICAL CHARACTERISTICS

$T_C = 25^\circ\text{C}$ ,  $V_{CC} = V_{CCN} = 5\text{V}$ ,  $OVDD = CSB = RFSW = 3.3\text{V}$ ,  $SDI = SCK = 0\text{V}$ ,  
 $VCM = 0.9\text{V}$ ,  $P_{IF} = 1.5\text{dBm}$  ( $-1.5\text{dBm/}$ tone for 2-tone tests),  $P_{LO} = 6\text{dBm}$ , all registers at default values unless otherwise noted.  
 (Notes 2, 3, 6, 9, 19, 22)

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
$f_{RF(RANGE)}$	RF Input Frequency Range	(Note 12)		0.3 to 6.0		GHz
$f_{LO(RANGE)}$	LO Input Frequency Range	(Note 12)		0.3 to 6.0		GHz
$RL_{RF}$	RF Input Return Loss	$f_{RF} = 300\text{MHz to } 500\text{MHz}$ (Note 5) $f_{RF} = 500\text{MHz to } 6.0\text{GHz}$		>10 >10		dB dB
$RL_{LO}$	LO Input Return Loss	$f_{LO} = 300\text{MHz to } 6.0\text{GHz}$		>10		dB
$P_{LO(RANGE)}$	LO Input Power Range	(Note 12)		-6 to 12		dBm
$G_P(MAX)$	Maximum Power Conversion Gain ATT = 0x00, AMPG = 0x06, $R_{LOAD} = 100\Omega$ Differential (Note 8)	$f_{RF} = 400\text{MHz}$ $f_{RF} = 900\text{MHz}$ $f_{RF} = 1900\text{MHz}$ $f_{RF} = 2600\text{MHz}$ $f_{RF} = 3500\text{MHz}$ $f_{RF} = 5800\text{MHz}$		7.4 9.2 7.7 7.1 4.3 0.7		dB dB dB dB dB dB
$G_P(MIN)$	Power Conversion Gain at Maximum Attenuation. ATT = 0x1F, AMPG = 0x06, $R_{LOAD} = 100\Omega$ , Differential (Note 8)	$f_{RF} = 400\text{MHz}$ $f_{RF} = 900\text{MHz}$ $f_{RF} = 1900\text{MHz}$ $f_{RF} = 2600\text{MHz}$ $f_{RF} = 3500\text{MHz}$ $f_{RF} = 5800\text{MHz}$		-23.3 -21.3 -21.8 -23.5 -24.0 -23.9		dB dB dB dB dB dB
	Attenuation Step Size			1.0		dB
	Attenuation Step Accuracy			0.2		dB
	RFA, RFB Gain Error			0.05		dB
	RFA, RFB Switching Time			100		ns
$AB_{ISO}$	RFA, RFB Isolation	$f_{RF} = 400\text{MHz}$ $f_{RF} = 900\text{MHz}$ $f_{RF} = 1900\text{MHz}$ $f_{RF} = 2600\text{MHz}$ $f_{RF} = 3500\text{MHz}$ $f_{RF} = 5800\text{MHz}$		49 48 40 42 38 25		dB dB dB dB dB dB
NF	Noise Figure, Double Side Band (Note 4)	$f_{RF} = 400\text{MHz}$ $f_{RF} = 900\text{MHz}$ $f_{RF} = 1900\text{MHz}$ $f_{RF} = 2600\text{MHz}$ $f_{RF} = 3500\text{MHz}$ $f_{RF} = 5800\text{MHz}$		19.0 17.8 19.5 21.1 23.2 31.0		dB dB dB dB dB dB
$NF_{BLOCKING}$	Noise Figure Under Blocking Conditions Double Side Band, $P_{IF, BLOCKER} = 1.5\text{dBm}$ (Note 7)	$f_{RF} = 400\text{MHz}$ $f_{RF} = 900\text{MHz}$ $f_{RF} = 1900\text{MHz}$ $f_{RF} = 2600\text{MHz}$ $f_{RF} = 3500\text{MHz}$ $f_{RF} = 5800\text{MHz}$		19.7 18.9 20.8 22.5 24.8 30.2		dB dB dB dB dB dB
OIP3	Output 3rd Order Intercept Unadjusted/Adjusted	$f_{RF} = 400\text{MHz}$ $f_{RF} = 900\text{MHz}$ $f_{RF} = 1900\text{MHz}$ $f_{RF} = 2600\text{MHz}$ $f_{RF} = 3500\text{MHz}$ $f_{RF} = 5800\text{MHz}$		41/44 42/43 40/42 38/40 35/36 32/33		dBm dBm dBm dBm dBm dBm
OIP2	Output 2nd Order Intercept Unadjusted/Adjusted	$f_{RF} = 400\text{MHz}$ $f_{RF} = 900\text{MHz}$ $f_{RF} = 1900\text{MHz}$ $f_{RF} = 2600\text{MHz}$ $f_{RF} = 3500\text{MHz}$ $f_{RF} = 5800\text{MHz}$		75/80 75/80 74/80 65/80 60/70 49/56		dBm dBm dBm dBm dBm dBm

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## ELECTRICAL CHARACTERISTICS

$T_C = 25^\circ\text{C}$ ,  $V_{CC} = V_{CCN} = 5\text{V}$ ,  $OVDD = CSB = RFSW = 3.3\text{V}$ ,  $SDI = SCK = 0\text{V}$ ,  $VCM = 0.9\text{V}$ ,  $P_{IF} = 1.5\text{dBm}$  ( $-1.5\text{dBm/}$ tone for 2-tone tests),  $P_{LO} = 6\text{dBm}$ , all registers at default values unless otherwise noted.  
(Notes 2, 3, 6, 9, 19, 22)

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
IIP3 <sub>DEMOD</sub>	Input 3rd Order Intercept Without Amplifier Unadjusted	$f_{RF} = 400\text{MHz}$		31		dBm
		$f_{RF} = 900\text{MHz}$		29		dBm
		$f_{RF} = 1900\text{MHz}$		30		dBm
		$f_{RF} = 2600\text{MHz}$		30		dBm
		$f_{RF} = 3500\text{MHz}$		30		dBm
		$f_{RF} = 5800\text{MHz}$		32		dBm
OIP3 <sub>AMP</sub>	Output 3rd Order Intercept, Amplifier Only (Note 15)	$f_{IF} = 10\text{MHz}$		42		dBm
		$f_{IF} = 100\text{MHz}$		41		dBm
		$f_{IF} = 200\text{MHz}$		38		dBm
		$f_{IF} = 300\text{MHz}$		37		dBm
		$f_{IF} = 500\text{MHz}$		35		dBm
		$f_{IF} = 1000\text{MHz}$		30		dBm
HD2	2nd Order Harmonic Distortion Unadjusted/Adjusted	$f_{RF} = 400\text{MHz}$		-63/-85		dBc
		$f_{RF} = 900\text{MHz}$		-62/-90		dBc
		$f_{RF} = 1900\text{MHz}$		-63/-90		dBc
		$f_{RF} = 2600\text{MHz}$		-61/-90		dBc
		$f_{RF} = 3500\text{MHz}$		-64/-85		dBc
		$f_{RF} = 5800\text{MHz}$		-52/-74		dBc
HD3	3rd Order Harmonic Distortion Unadjusted/Adjusted	$f_{RF} = 400\text{MHz}$		-83/-84		dBc
		$f_{RF} = 900\text{MHz}$		-80/-81		dBc
		$f_{RF} = 1900\text{MHz}$		-80/-81		dBc
		$f_{RF} = 2600\text{MHz}$		-80/-80		dBc
		$f_{RF} = 3500\text{MHz}$		-79/-78		dBc
		$f_{RF} = 5800\text{MHz}$		-69/-73		dBc
P1dB	Output 1dB Compression Point	$f_{RF} = 400\text{MHz}$		10.5		dBm
		$f_{RF} = 900\text{MHz}$		13		dBm
		$f_{RF} = 1900\text{MHz}$		13		dBm
		$f_{RF} = 2600\text{MHz}$		13		dBm
		$f_{RF} = 3500\text{MHz}$		13		dBm
		$f_{RF} = 5800\text{MHz}$		12.5		dBm
DC <sub>OFFSET</sub>	DC Offset, Unadjusted (Note 13)	$f_{RF} = 400\text{MHz}$		20		mV
		$f_{RF} = 900\text{MHz}$		21		mV
		$f_{RF} = 1900\text{MHz}$		22		mV
		$f_{RF} = 2600\text{MHz}$		25		mV
		$f_{RF} = 3500\text{MHz}$		35		mV
		$f_{RF} = 5800\text{MHz}$		45		mV
DC <sub>OFF(RANGE)</sub>	DC Offset Adjustment Range	DCOI, DCOQ = 0x00 to 0xFF		-75 to 75		mV
DC <sub>OFF(STEP)</sub>	DC Offset Step Size			640		$\mu\text{V}$
$\Delta\text{G}$	I/Q Gain Mismatch, Unadjusted	$f_{RF} = 400\text{MHz}$		0.04		dB
		$f_{RF} = 900\text{MHz}$		0.05		dB
		$f_{RF} = 1900\text{MHz}$		0.06		dB
		$f_{RF} = 2600\text{MHz}$		0.06		dB
		$f_{RF} = 3500\text{MHz}$		0.07		dB
		$f_{RF} = 5800\text{MHz}$		0.10		dB
$\Delta\text{G(RANGE)}$	I/Q Gain Mismatch Adjustment Range	GERR = 0x00 to 0x3F		-0.5 to 0.5		dB
$\Delta\text{G(STEP)}$	I/Q Gain Mismatch Adjustment Step Size			0.016		dB
$\Delta\phi$	I/Q Phase Mismatch, Unadjusted	$f_{RF} = 400\text{MHz}$		0.4		Deg
		$f_{RF} = 900\text{MHz}$		1.1		Deg
		$f_{RF} = 1900\text{MHz}$		1.1		Deg
		$f_{RF} = 2600\text{MHz}$		2.3		Deg
		$f_{RF} = 3500\text{MHz}$		3.2		Deg
		$f_{RF} = 5800\text{MHz}$		0.3		Deg
$\Delta\phi(\text{RANGE})$	I/Q Phase Mismatch Adjustment Range	PHA = 0x000 to 0x1FF		-2.5 to 2.5		Deg

## ELECTRICAL CHARACTERISTICS

$T_C = 25^\circ\text{C}$ ,  $V_{CC} = V_{CCN} = 5\text{V}$ ,  $OV_{DD} = CSB = RFSW = 3.3\text{V}$ ,  $SDI = SCK = 0\text{V}$ ,  $V_{CM} = 0.9\text{V}$ ,  $P_{IF} = 1.5\text{dBm}$  ( $-1.5\text{dBm/}$ tone for 2-tone tests),  $P_{LO} = 6\text{dBm}$ , all registers at default values unless otherwise noted.  
(Notes 2, 3, 6, 9, 19, 22)

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
$\Delta\phi_{(\text{STEP})}$	I/Q Phase Mismatch Adjustment Step Size			0.05		Deg
IRR	Image Rejection Ratio Unadjusted/Adjusted (Note 10)	$f_{RF} = 400\text{MHz}$ $f_{RF} = 700\text{MHz}$ $f_{RF} = 1900\text{MHz}$ $f_{RF} = 2600\text{MHz}$ $f_{RF} = 3500\text{MHz}$ $f_{RF} = 5800\text{MHz}$		51/68 44/70 45/68 39/69 33/70 39/70		dB dB dB dB dB dB
$LR_{\text{LEAK}}$	LO to RF Leakage	$f_{LO} = 400\text{MHz}$ $f_{LO} = 900\text{MHz}$ $f_{LO} = 1900\text{MHz}$ $f_{LO} = 2600\text{MHz}$ $f_{LO} = 3500\text{MHz}$ $f_{LO} = 5800\text{MHz}$		-67 -63 -56 -55 -45 -47		dBm dBm dBm dBm dBm dBm
$RL_{\text{ISO}}$	RF to LO Isolation	$f_{RF} = 400\text{MHz}$ $f_{RF} = 900\text{MHz}$ $f_{RF} = 1900\text{MHz}$ $f_{RF} = 2600\text{MHz}$ $f_{RF} = 3500\text{MHz}$ $f_{RF} = 5800\text{MHz}$		59 65 66 62 57 52		dB dB dB dB dB dB
$RI_{\text{ISO}}$	RF to IF Isolation (Note 16)	$f_{RF} = 400\text{MHz}$ $f_{RF} = 900\text{MHz}$ $f_{RF} = 1900\text{MHz}$ $f_{RF} = 2600\text{MHz}$ $f_{RF} = 3500\text{MHz}$ $f_{RF} = 5800\text{MHz}$		70 65 50 53 48 47		dB dB dB dB dB dB
$LI_{\text{LEAK}}$	LO to IF Leakage (Note 16)	$f_{LO} = 400\text{MHz}$ $f_{LO} = 900\text{MHz}$ $f_{LO} = 1900\text{MHz}$ $f_{LO} = 2600\text{MHz}$ $f_{LO} = 3500\text{MHz}$ $f_{LO} = 5800\text{MHz}$		-37 -36 -34 -33 -42 -36		dBm dBm dBm dBm dBm dBm

### Power Supply and Other Parameters

$V_{CC}, V_{CCN}$	Supply Voltage		4.75	5.0	5.25	V
$I_{CC}$	Supply Current		430	440	470	mA
$I_{VCCN}$	Supply Current to VCCN Pin			700		$\mu\text{A}$
$OV_{DD}$	Digital I/O Supply Voltage			1.2 to 3.3		V
$V_{DH}$	RFSW Input High Voltage (On)		$0.7 \cdot OV_{DD}$			V
$V_{DL}$	RFSW Input Low Voltage (Off)			$0.3 \cdot OV_{DD}$		V
$I_{RFSW}$	RFSW Pin Input Current	RFSW = 3.3V		1		$\mu\text{A}$
$V_{\text{TEMP}}$	TEMP Diode Bias Voltage	$I_{\text{TEMP}} = 100\mu\text{A}$ into TEMP pin		0.774		V
	TEMP Diode Temperature Slope	$I_{\text{TEMP}} = 100\mu\text{A}$ into TEMP pin		-1.52		$\text{mV}/^\circ\text{C}$
$Z_{\text{MIX}(\text{OUT})}$	Mixer Output Impedance	Differential		100  0.6		$\Omega  \text{pF}$
$V_{\text{MIX}(\text{OUT})}$	Mixer Output DC Voltage	Common-Mode		3.7		V
$Z_{\text{AMP}(\text{IN})}$	Amplifier Input Impedance	Differential		200  0.2		$\Omega  \text{pF}$
$V_{\text{AMP}(\text{IN})}$	Amplifier DC Input Voltage	Common-Mode		3.0 to 4.0		V
$Z_{\text{AMP}(\text{OUT})}$	Amplifier Output Impedance	Differential		4  0.5		$\text{k}\Omega  \text{pF}$
$I_{\text{AMP}(\text{SC})}$	Amplifier DC Output Short Circuit Current	IFIP = IFIM = IFQP = IFQM = 0V		100		mA
$V_{\text{CM}(\text{RANGE})}$	VCM Pin Voltage Range (Notes 11, 12)			0.5 to 2.0		V

## ELECTRICAL CHARACTERISTICS

$T_C = 25^\circ\text{C}$ ,  $V_{CC} = V_{CCN} = 5\text{V}$ ,  $OVDD = CSB = RFSW = 3.3\text{V}$ ,  $SDI = SCK = 0\text{V}$ ,  $VCM = 0.9\text{V}$ ,  $P_{IF} = 1.5\text{dBm}$  ( $-1.5\text{dBm}/\text{tone}$  for 2-tone tests),  $P_{LO} = 6\text{dBm}$ , all registers at default values unless otherwise noted. (Notes 2, 3, 6, 9, 19, 22)

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
$BW_{IF}$	IF Output Bandwidth	-1dB Corner Frequency (Note 20)		1.0		GHz

### Serial Interface Pins

$V_{IH}$	High Level Input Voltage	CSB, SDI, SCK	$0.7 \cdot OV_{DD}$			V
$V_{IL}$	Low Level Input Voltage	CSB, SDI, SCK			$0.3 \cdot OV_{DD}$	V
$V_{IHYS}$	Input Hysteresis Voltage	CSB, SDI, SCK		250		mV
$I_{IN(SER)}$	Input Current	CSB, SDI, SCK (Note 17)			30	$\mu\text{A}$
$V_{OH}$	High Level Output Voltage	SDO, 10mA Current Sink	$0.7 \cdot OV_{DD}$			V
$V_{OL}$	Low Level Output Voltage	SDO, 10mA Current Source			$0.3 \cdot OV_{DD}$	V

### Serial Interface Timing

$t_{CKH}$	SCK High Time		25			ns
$t_{CKL}$	SCK Low Time		25			ns
$t_{CSS}$	CSB Setup Time		10			ns
$t_{CSH}$	CSB High Time		10			ns
$t_{DS}$	SDI to SCK Setup Time		6			ns
$t_{DH}$	SDI to SCK Hold Time		6			ns
$t_{DO}$	SCK to SDO Time	To $V_{IH}/V_{IL}/\text{Hi-Z}$ with 30pF Load			16	ns

**Note 1:** Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime. The voltage on all pins should not exceed  $V_{CC} + 0.3\text{V}$  or be less than  $-0.3\text{V}$ , otherwise damage to the ESD diodes may occur.

**Note 2:** Tests are performed with the test circuit of Figure 1.

**Note 3:** The LTC5586 is guaranteed to be functional over the  $-40^\circ\text{C}$  to  $105^\circ\text{C}$  case temperature operating range.

**Note 4:** DSB noise figure is measured at the baseband frequency of 15MHz with a small-signal noise source without any filtering on the RF input and no other RF signal applied.

**Note 5:** A 4.7pF shunt capacitor is used on the RF inputs for 300MHz to 500MHz. 0.3pF is used for 500MHz to 6GHz.

**Note 6:** The differential amplifier outputs (IFIP, IFIM and IFQP, IFQM) are combined using a  $180^\circ$  combiner.

**Note 7:** Noise figure under blocking conditions ( $NF_{\text{BLOCKING}}$ ) is measured at an output frequency of 60MHz with RF input signal at  $f_{LO} + 1\text{MHz}$ . Both RF and LO input signals are appropriately filtered, as well as the baseband output.

**Note 8:** Power conversion gain is measured with a  $100\Omega$  differential load impedance on the I and Q outputs. Any losses due to IF combiner and spectrum analyzer termination have been de-embedded.

**Note 9:** Input  $P_{RF}$  adjusted so that  $P_{IF} = -1.5\text{dBm}/\text{tone}$  at the amplifier output. RF tone spacing set at 4MHz with high-side LO,  $f_{LO} = f_{RF} + 30\text{MHz}$ .

**Note 10:** Image rejection is measured at  $f_{IF} = 12\text{MHz}$  and calculated from the measured gain error and phase error.

**Note 11:** If the VCM pin is left floating, it will self bias to a nominal 0.9V.

**Note 12:** This is the recommended operating range, operation outside the listed range is possible with degraded performance to some parameters.

**Note 13:** DC offset measured differentially between IFIP and IFIM and between IFQP and IFQM. The reported value is the mean of the absolute values of the characterization data distribution.

**Note 14:** IF outputs shorted to ground.

**Note 15:** IF tone spacing set at 1MHz.

**Note 16:** Worst case leakage or isolation measured to each IF single-ended port.

**Note 17:** Guaranteed by design characterization, not tested in production.

**Note 18:** The voltage on the OVDD pin must never exceed  $V_{CC} + 0.3\text{V}$ , otherwise damage to the ESD diodes may occur.

**Note 19:** Refer to Appendix for register definition and default values.

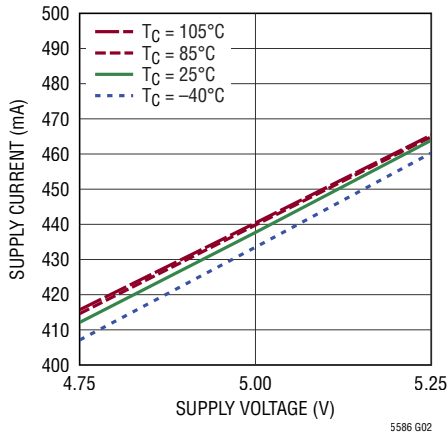
**Note 20:** Mixer outputs directly connected to amplifier inputs. Bandwidth measured on single amplifier output, I or Q.

**Note 21:**  $V_{CC}$  should be ramped up slower than 5V/ms to prevent damage.

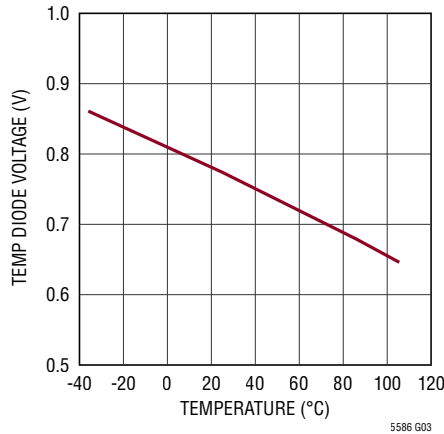
**Note 22:**  $P_{IF}$  measured at amplifier differential outputs.

**TYPICAL PERFORMANCE CHARACTERISTICS**  $V_{CC} = V_{CCN} = 5V$ ,  $T_C = 25^\circ C$ ,  $P_{LO} = 6dBm$ , HSLO, RF tone spacing = 4MHz,  $f_{IF} = 30MHz$ ,  $P_{IF} = -1.5dBm$  per tone, and register defaults. DC Blocks,  $50\Omega$  terminations, and MACOM H9 180° combiner at amplifier outputs de-embedded from measurement unless otherwise noted. Test circuit shown in Figure 1 with 500MHz interstage filter.

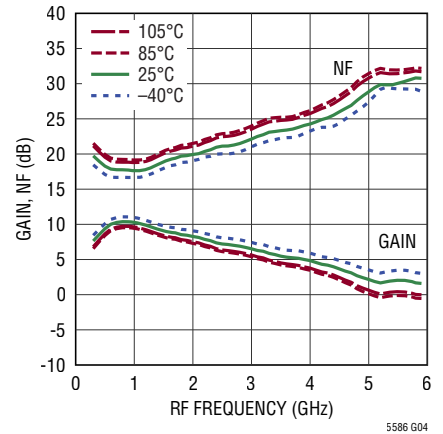
Supply Current vs Supply Voltage



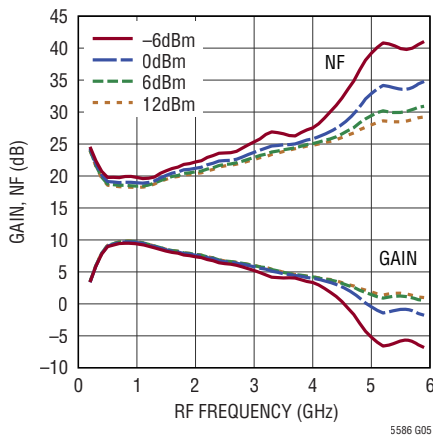
TEMP Diode Voltage vs Temperature ( $T_C$ )



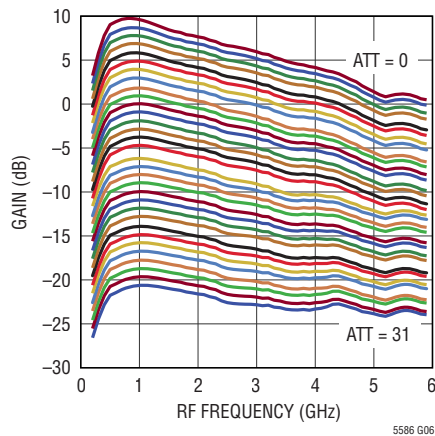
Noise Figure and Conversion Gain vs Temperature ( $T_C$ )



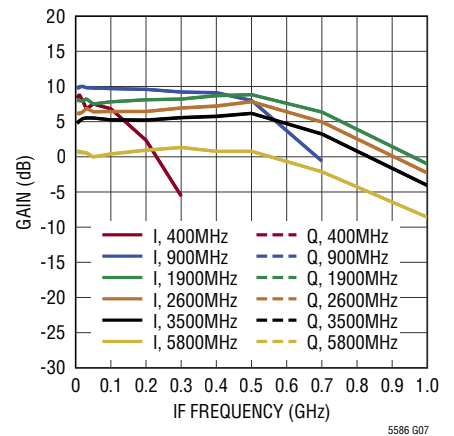
Noise Figure and Conversion Gain vs LO Power



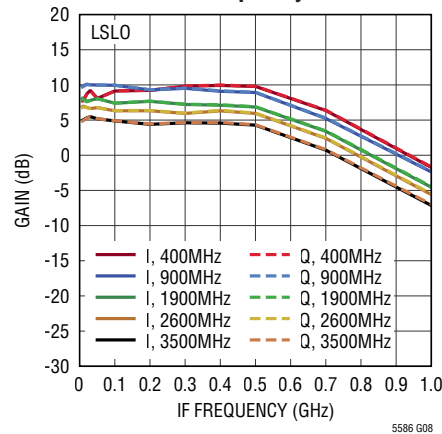
Conversion Gain vs ATT Setting



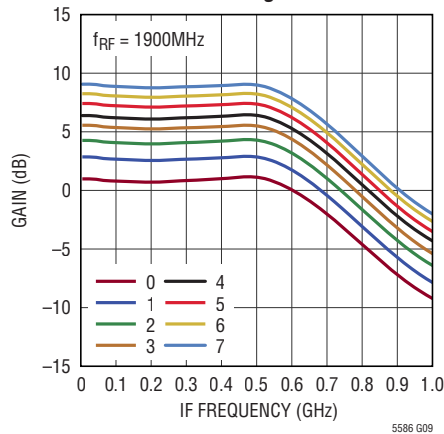
Gain vs RF Frequency



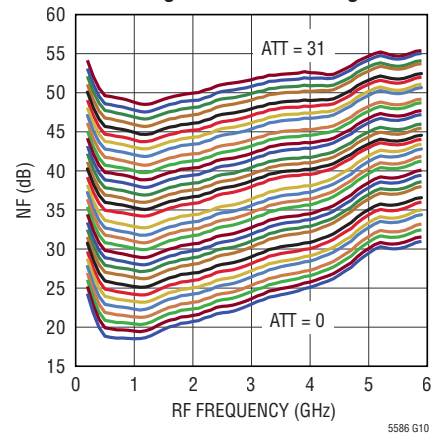
Gain vs RF Frequency for LSLO



Gain vs AMPG Register Value

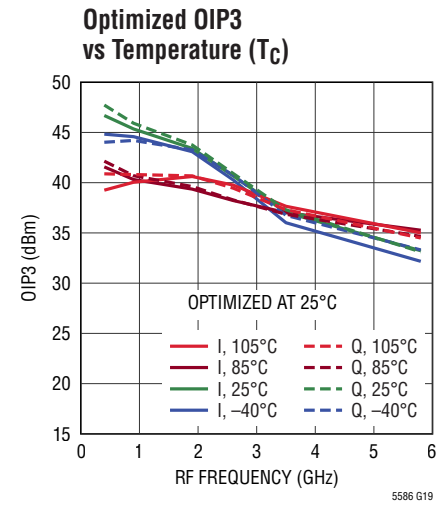
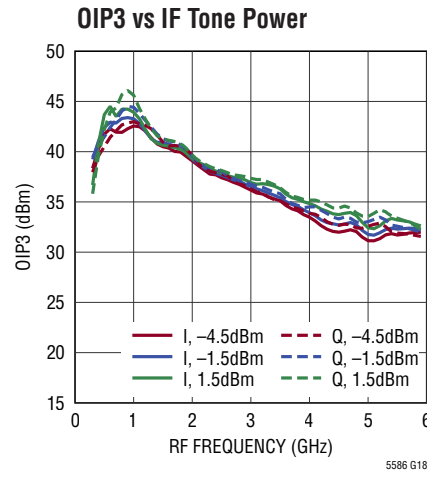
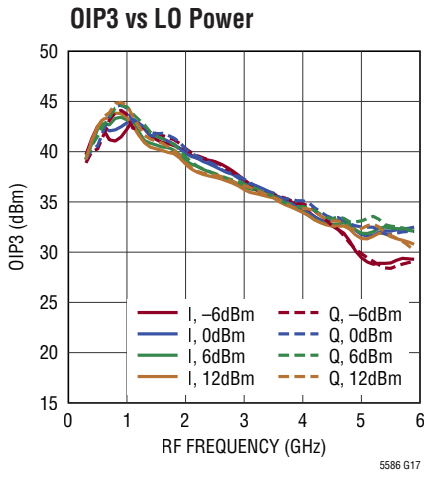
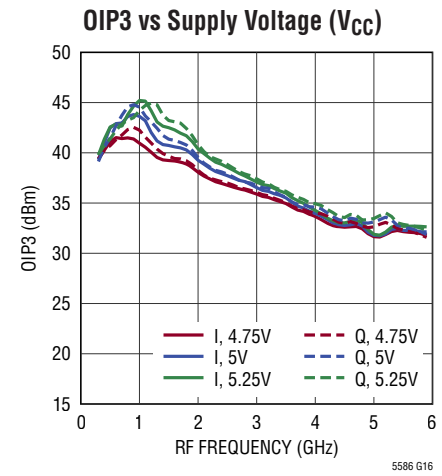
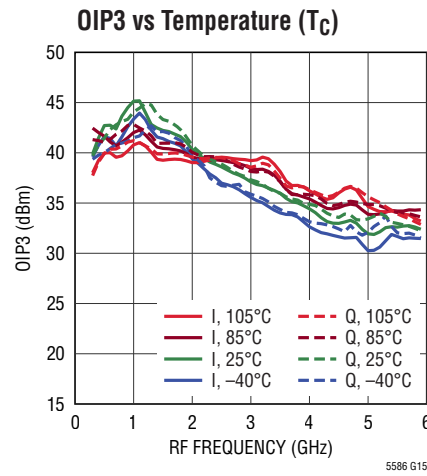
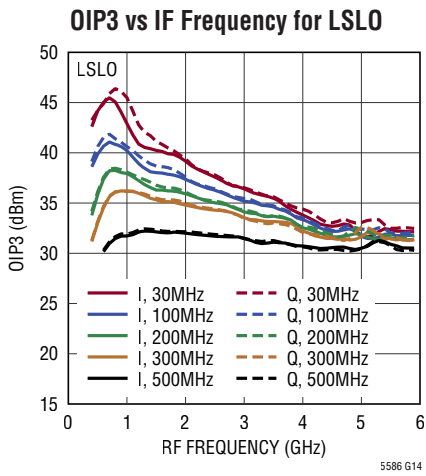
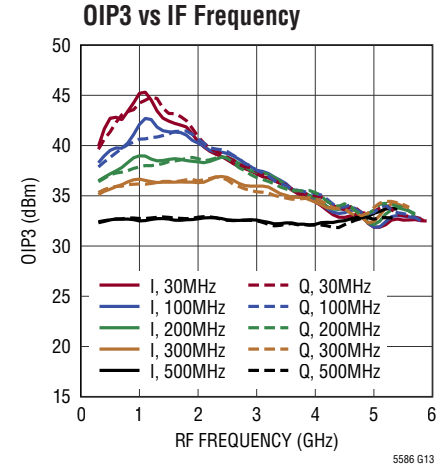
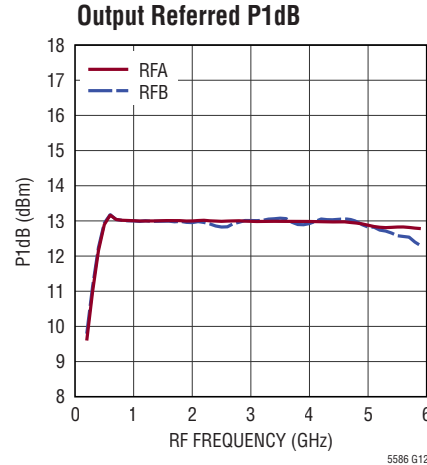
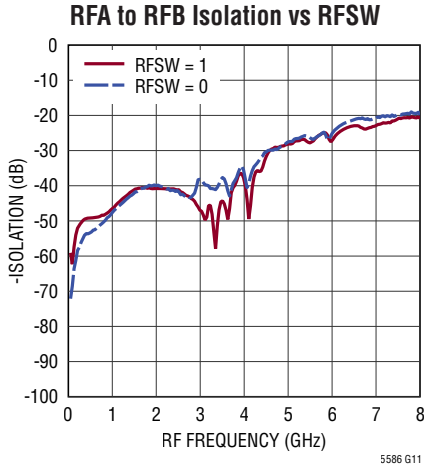


Noise Figure vs ATT Setting



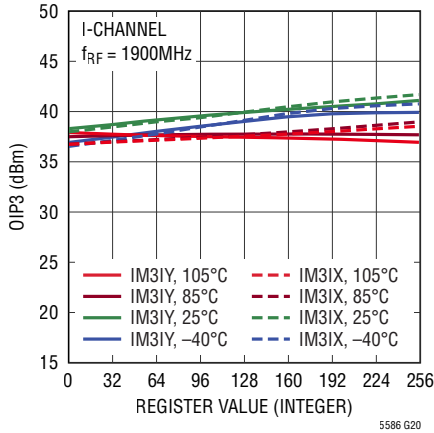


**TYPICAL PERFORMANCE CHARACTERISTICS**  $V_{CC} = V_{CCN} = 5V$ ,  $T_C = 25^\circ C$ ,  $P_{LO} = 6dBm$ , HSLO, RF tone spacing = 4MHz,  $f_{IF} = 30MHz$ ,  $P_{IF} = -1.5dBm$  per tone, and register defaults. DC Blocks,  $50\Omega$  terminations, and MACOM H9 180° combiner at amplifier outputs de-embedded from measurement unless otherwise noted. Test circuit shown in Figure 1 with 500MHz interstage filter.

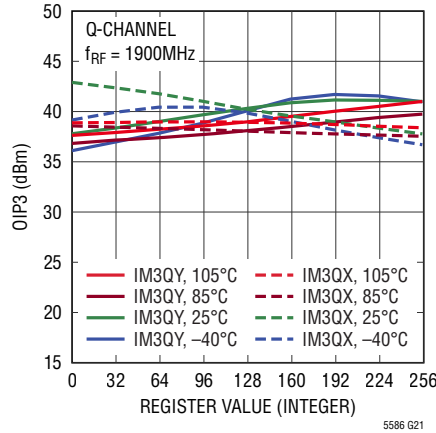


**TYPICAL PERFORMANCE CHARACTERISTICS**  $V_{CC} = V_{CCN} = 5V$ ,  $T_C = 25^\circ C$ ,  $P_{LO} = 6dBm$ , HSLO, RF tone spacing = 4MHz,  $f_{IF} = 30MHz$ ,  $P_{IF} = -1.5dBm$  per tone, and register defaults. DC Blocks,  $50\Omega$  terminations, and MACOM H9 180° combiner at amplifier outputs de-embedded from measurement unless otherwise noted. Test circuit shown in Figure 1 with 500MHz interstage filter.

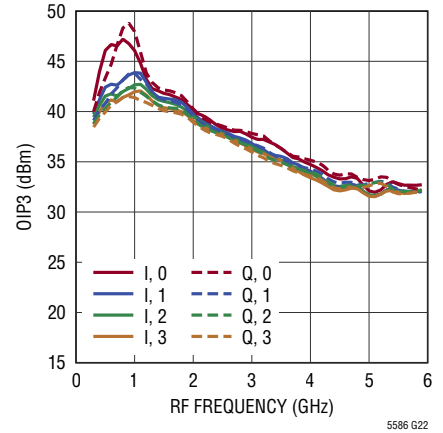
**OIP3 vs Temperature ( $T_C$ ) and Register Value, I-Channel**



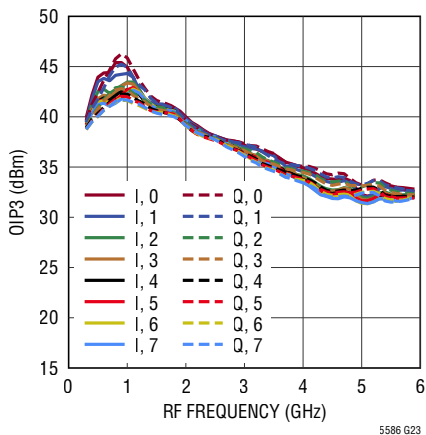
**OIP3 vs Temperature ( $T_C$ ) and Register Value, Q-Channel**



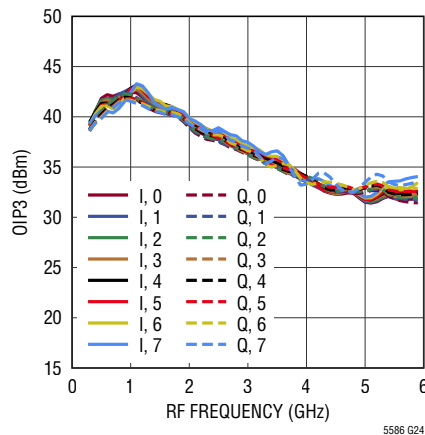
**OIP3 vs IP3CC Register Value**



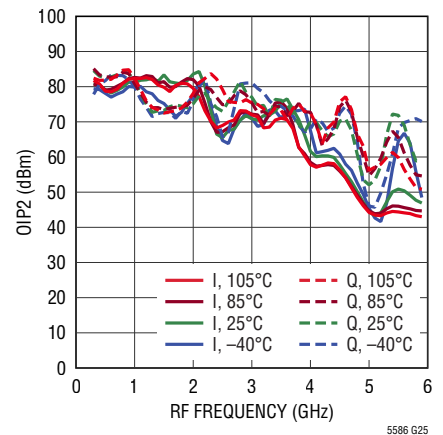
**OIP3 vs IP3IC Register Value**



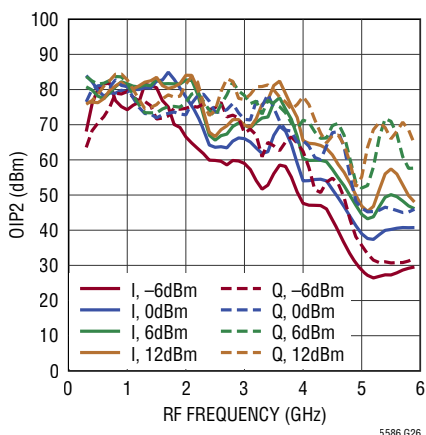
**OIP3 vs LVCM Register Value**



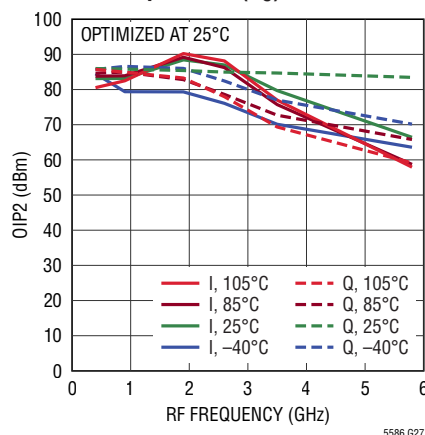
**OIP2 vs Temperature ( $T_C$ )**



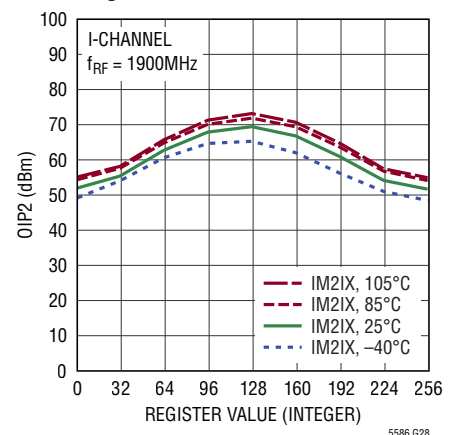
**OIP2 vs LO Power**



**Optimized OIP2 vs Temperature ( $T_C$ )**

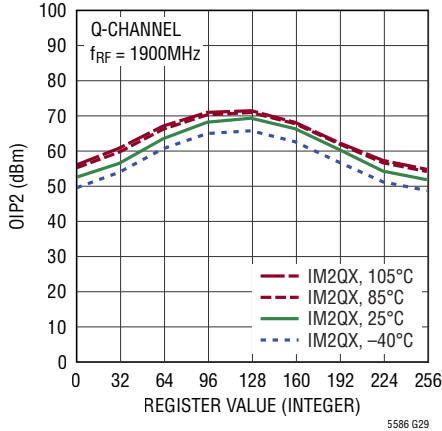


**OIP2 vs Temperature ( $T_C$ ) and Register Value, I-Channel**

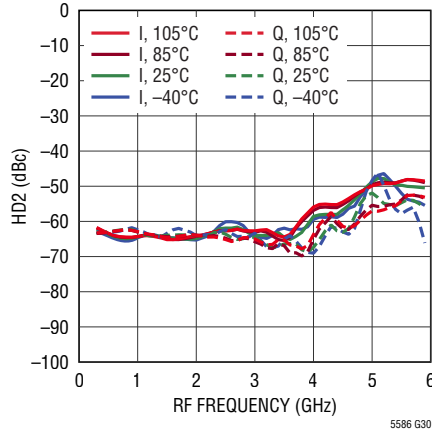


**TYPICAL PERFORMANCE CHARACTERISTICS**  $V_{CC} = V_{CCN} = 5V$ ,  $T_C = 25^\circ C$ ,  $P_{LO} = 6dBm$ , HSLO, RF tone spacing = 4MHz,  $f_{IF} = 30MHz$ ,  $P_{IF} = -1.5dBm$  per tone, and register defaults. DC Blocks,  $50\Omega$  terminations, and MACOM H9 180° combiner at amplifier outputs de-embedded from measurement unless otherwise noted. Test circuit shown in Figure 1 with 500MHz interstage filter.

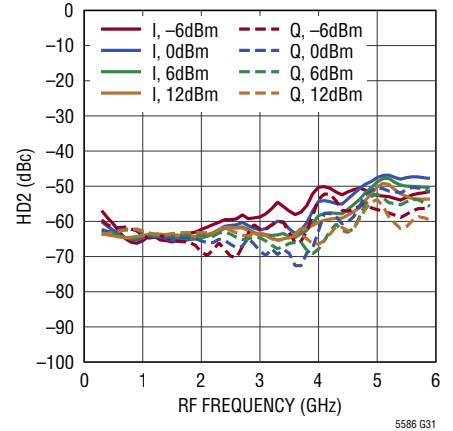
**OIP2 vs Temperature ( $T_C$ ) and Register Value, Q-Channel**



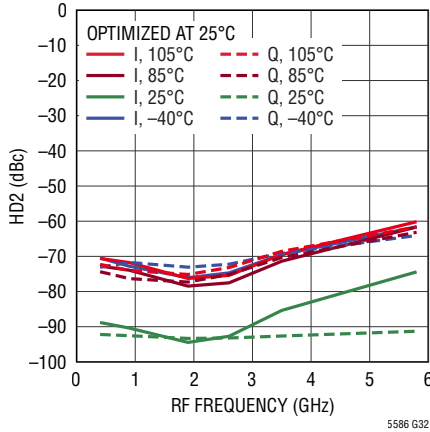
**HD2 vs Temperature ( $T_C$ )**



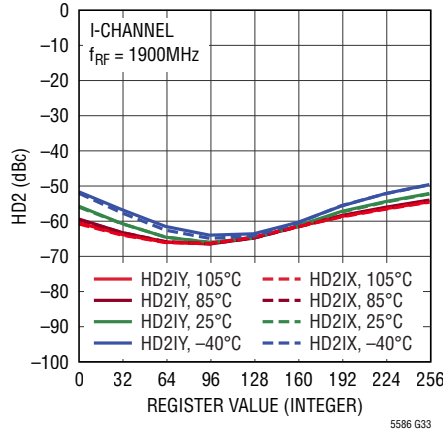
**HD2 vs LO Power**



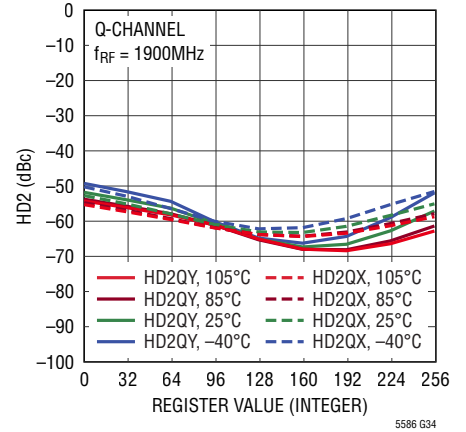
**Optimized HD2 vs Temperature ( $T_C$ )**



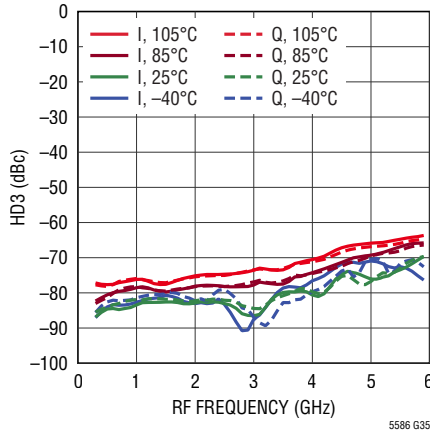
**HD2 vs Temperature ( $T_C$ ) and Register Value, I-Channel**



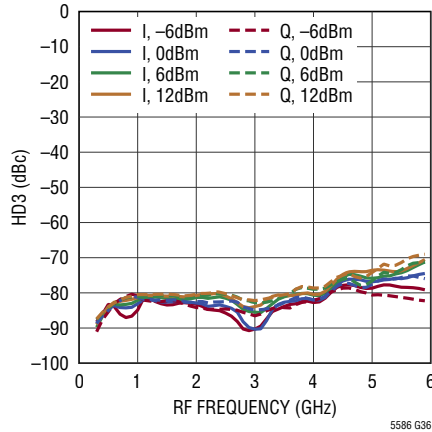
**HD2 vs Temperature ( $T_C$ ) and Register Value, Q-Channel**



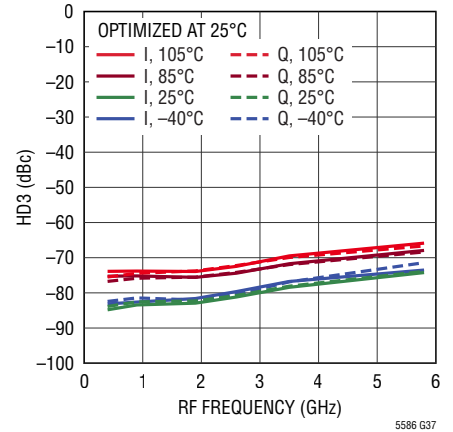
**HD3 vs Temperature ( $T_C$ )**



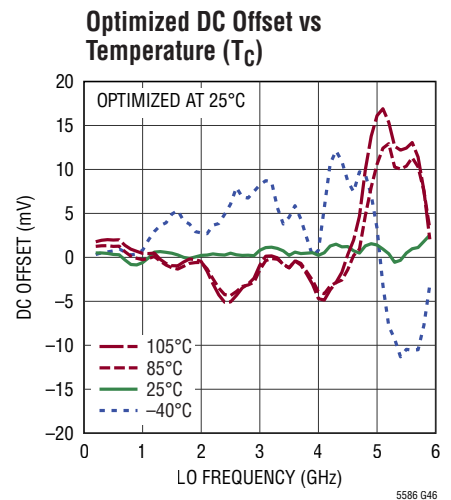
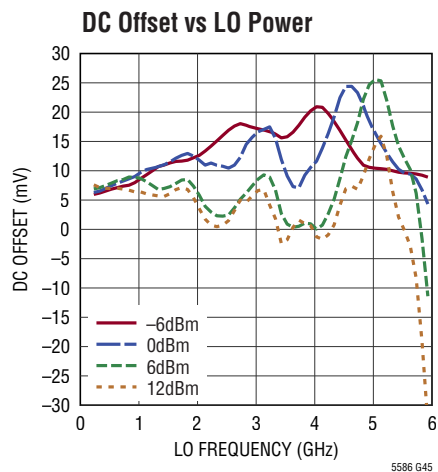
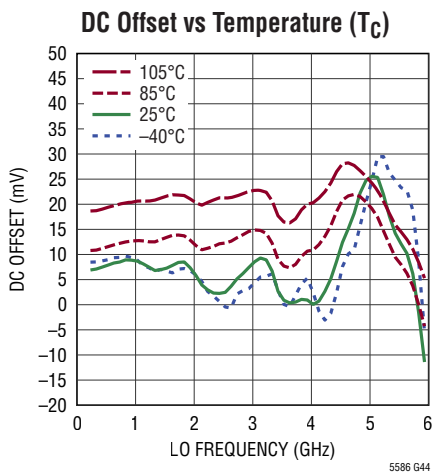
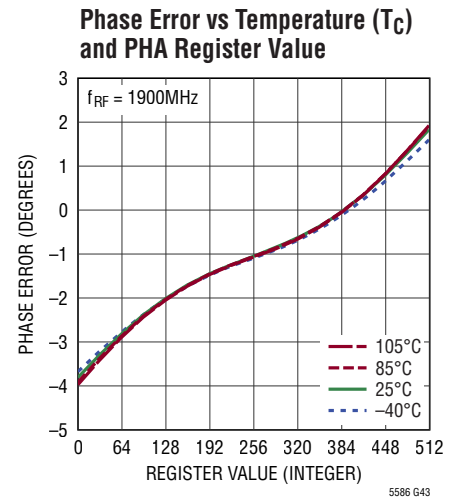
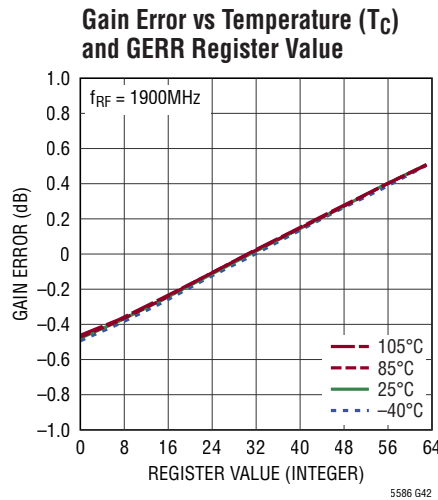
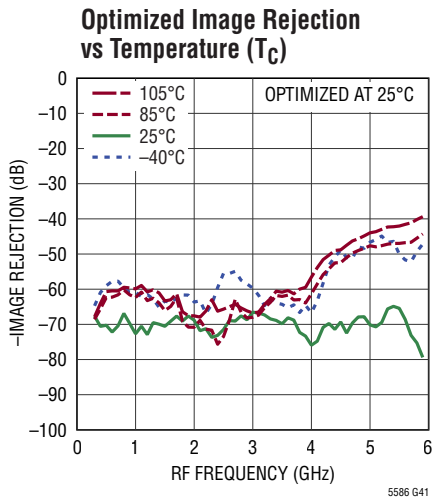
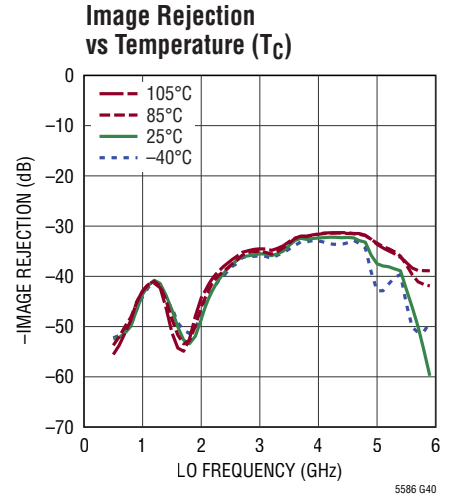
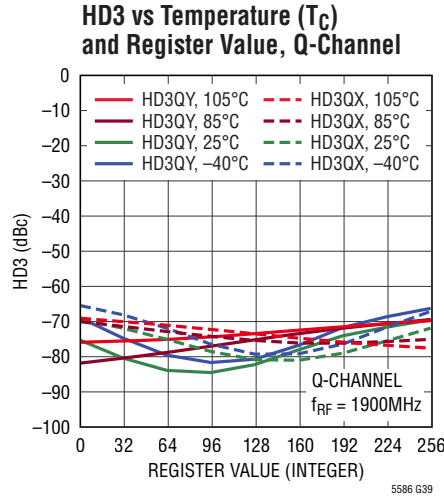
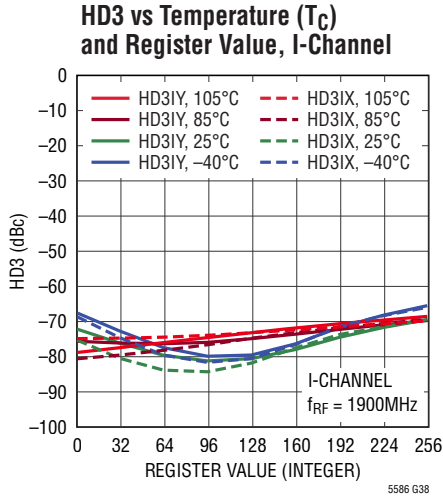
**HD3 vs LO Power**



**Optimized HD3 vs Temperature ( $T_C$ )**

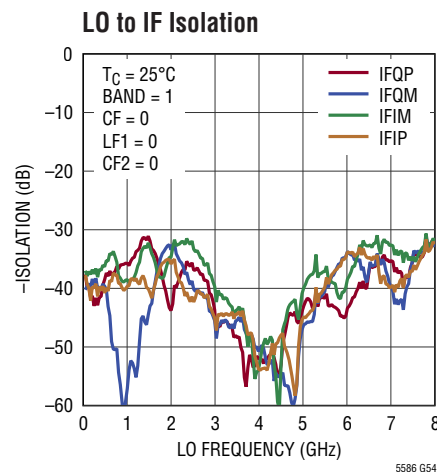
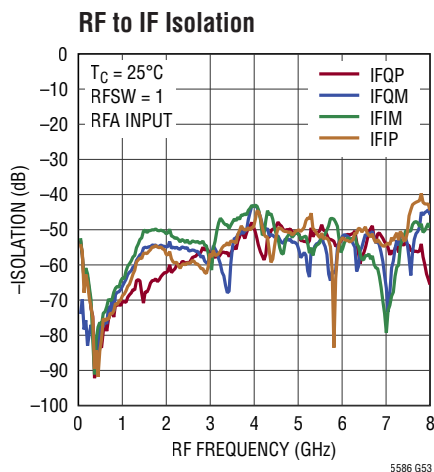
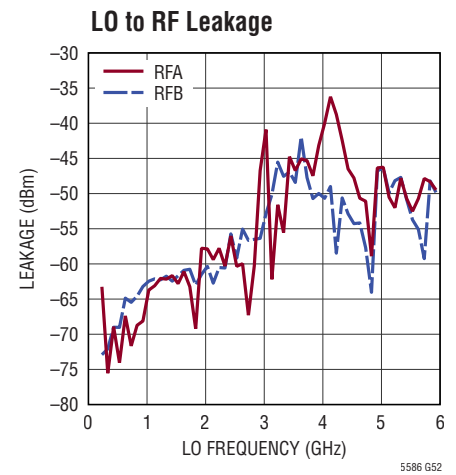
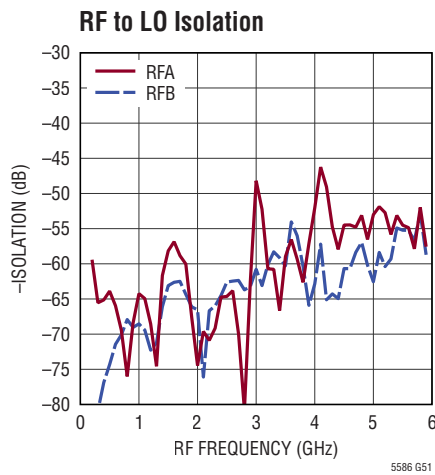
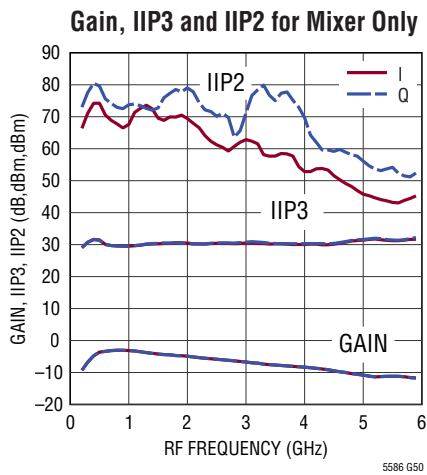
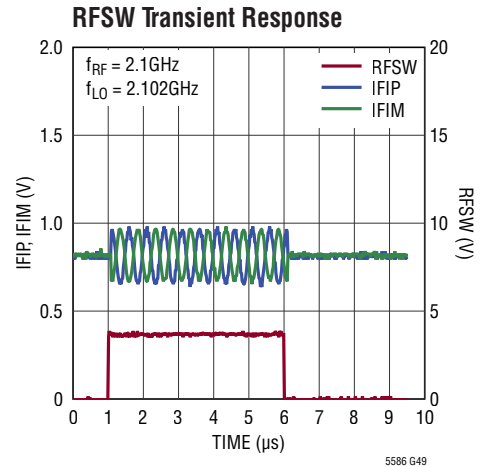
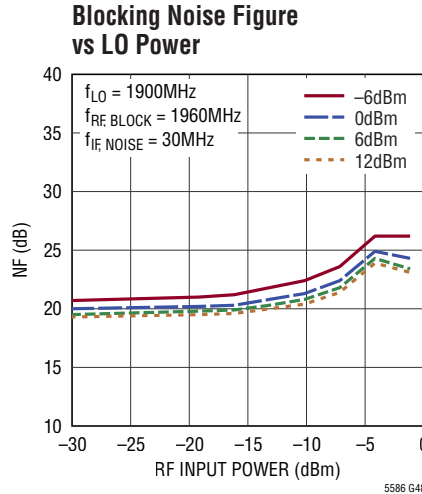
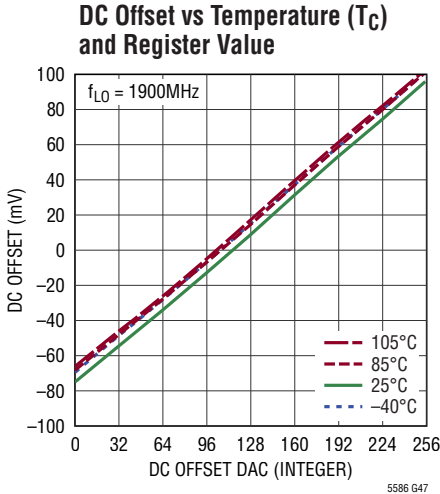


**TYPICAL PERFORMANCE CHARACTERISTICS**  $V_{CC} = V_{CCN} = 5V$ ,  $T_C = 25^\circ C$ ,  $P_{LO} = 6dBm$ , HSLO, RF tone spacing = 4MHz,  $f_{IF} = 30MHz$ ,  $P_{IF} = -1.5dBm$  per tone, and register defaults. DC Blocks,  $50\Omega$  terminations, and MACOM H9 180° combiner at amplifier outputs de-embedded from measurement unless otherwise noted. Test circuit shown in Figure 1 with 500MHz interstage filter.



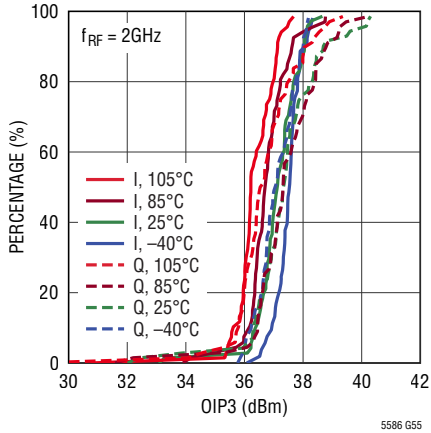


**TYPICAL PERFORMANCE CHARACTERISTICS**  $V_{CC} = V_{CCN} = 5V$ ,  $T_C = 25^\circ C$ ,  $P_{LO} = 6dBm$ , HSLO, RF tone spacing = 4MHz,  $f_{IF} = 30MHz$ ,  $P_{IF} = -1.5dBm$  per tone, and register defaults. DC Blocks,  $50\Omega$  terminations, and MACOM H9 180° combiner at amplifier outputs de-embedded from measurement unless otherwise noted. Test circuit shown in Figure 1 with 500MHz interstage filter.

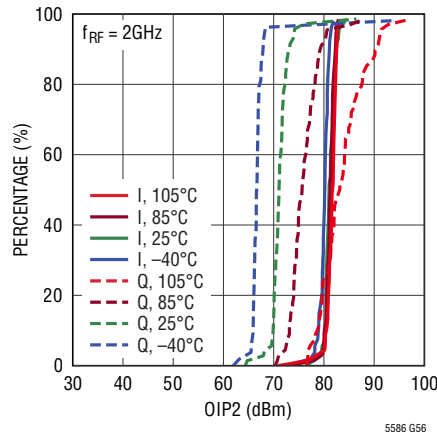


**TYPICAL PERFORMANCE CHARACTERISTICS**  $V_{CC} = V_{CCN} = 5V$ ,  $T_C = 25^\circ C$ ,  $P_{LO} = 6dBm$ , HSLO, RF tone spacing = 4MHz,  $f_{IF} = 30MHz$ ,  $P_{IF} = -1.5dBm$  per tone, and register defaults. DC Blocks,  $50\Omega$  terminations, and MACOM H9 180° combiner at amplifier outputs de-embedded from measurement unless otherwise noted. Test circuit shown in Figure 1 with 500MHz interstage filter.

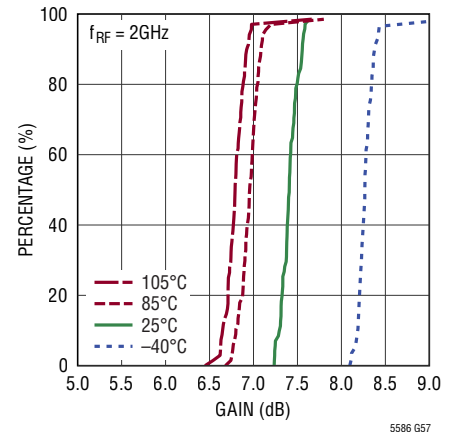
**OIP3 Distribution vs Temperature ( $T_C$ )**



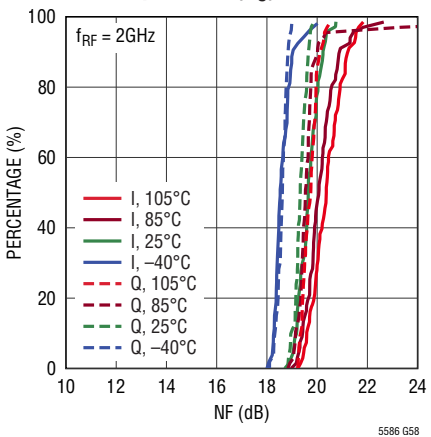
**OIP2 Distribution vs Temperature ( $T_C$ )**



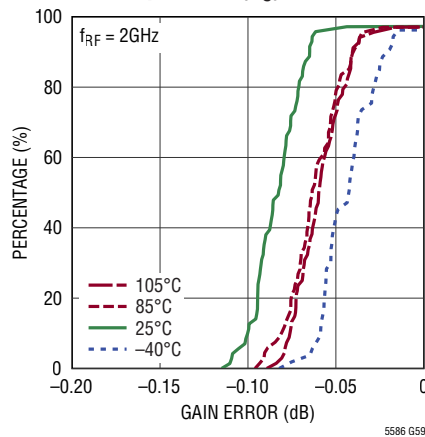
**Conversion Gain Distribution vs Temperature ( $T_C$ )**



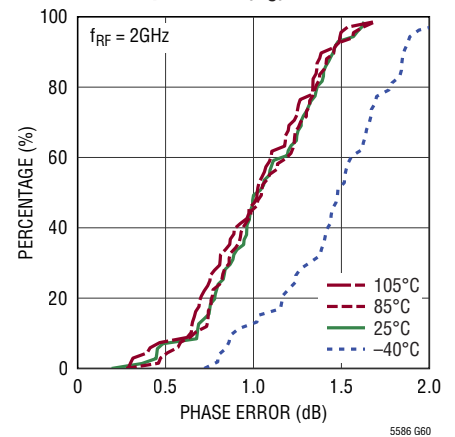
**Noise Figure Distribution vs Temperature ( $T_C$ )**



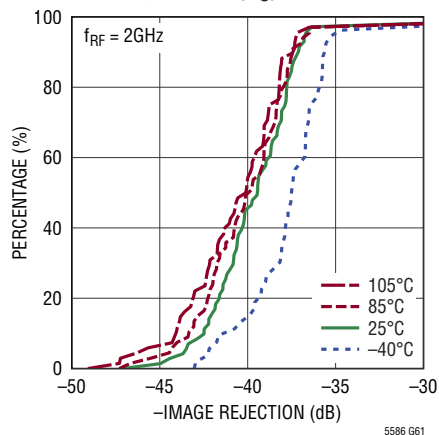
**Gain Error Distribution vs Temperature ( $T_C$ )**



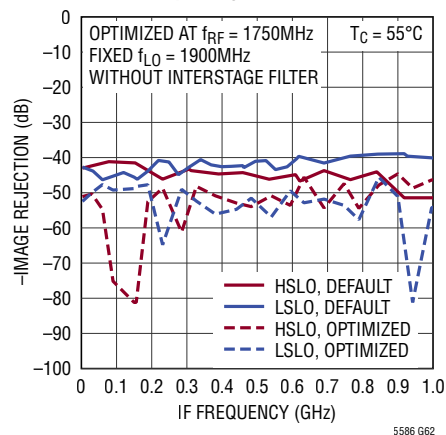
**Phase Error Distribution vs Temperature ( $T_C$ )**



**Image Rejection Distribution vs Temperature ( $T_C$ )**



**Optimized Image Rejection vs IF Frequency**



## PIN FUNCTIONS

**RFA (Pin 2):** 50Ω switched RF input. The pin should be DC-blocked with coupling capacitor; 1000pF is recommended.

**TEMP (Pin 3):** Temperature monitoring diode. The diode to ground at this pin can be used to measure the die temperature. A forward bias current of 100μA can be used into this pin and the forward voltage drop can be measured as a function of die temperature.

**RFSW (Pin 4):** RF channel select. The state of the RF switch is the logical AND of the RFSW pin and the RFSW register value. (See Appendix). This pin should not be left floating. Either tie high or low.

**VCCN (Pin 5):** Positive Supply Pin. This pin must be tied to the VCC pin.

**VCM (Pin 6):** IF amplifier common-mode output voltage adjust. Source resistance should be 1kΩ or lower. If this pin is left unconnected, it will internally self-bias to 0.9V.

**RFB (Pin 7):** 50Ω switched RF input. The pin should be DC-blocked with coupling capacitor; 1000pF is recommended.

**MQP, MQM, MIM, MIP (Pins 9, 10, 31, 32):** Mixer differential output pins. When connected to the amplifier input pins, the DC bias point is  $V_{CC} - 1.3V$  for each pin. A low-pass filter is typically used between the MQM(P) or MIM(P) pins and the AQM(P) or AIM(P) pins to suppress the high frequency mixing products. See the Applications section for more information.

**DNC (Pins 11, 14, 27, 30):** DO NOT CONNECT. No connection should be made to these pins.

**AQM, AQP, AIP, AIM (Pins 12, 13, 28, 29):** Amplifier differential input pins. When connected to the mixer output pins, the DC bias point is  $V_{CC} - 1.3V$  for each pin. A low-pass filter is typically used between the AQM(P) or AIM(P) pins and the MQM(P) or MIM(P) pins to suppress the high frequency mixing products. See the Applications section for more information.

**IFQM, IFQP, IFIP, IFIM (Pins 15, 16, 25, 26):** IF amplifier output pins. The current used by the output amplifiers

is set by a resistance of 25Ω to 200Ω from each pin to ground and the VCM control voltage.

**CSB (Pin 17):** Chip Select Bar. When CSB is low, the serial interface is enabled. It can be driven with 1.2V to 3.3V logic levels.

**VCC (Pin 18):** Positive supply pin. This pin should be bypassed with a 1000pF and 4.7μF capacitor to ground.

**LOP, LOM (Pins 19, 20):** LO inputs. External matching is not needed. Can be driven 50Ω single-ended or 100Ω differentially. The LO pins should be DC-blocked with coupling capacitor; 1000pF is recommended. When driven single-ended, the unused pin should be terminated with 50Ω in series with the DC-blocking capacitor.

**SDO (Pin 21):** Serial Data Output. This output can accommodate logic levels from 1.2V to 3.3V. During read-mode, data is read out MSB first.

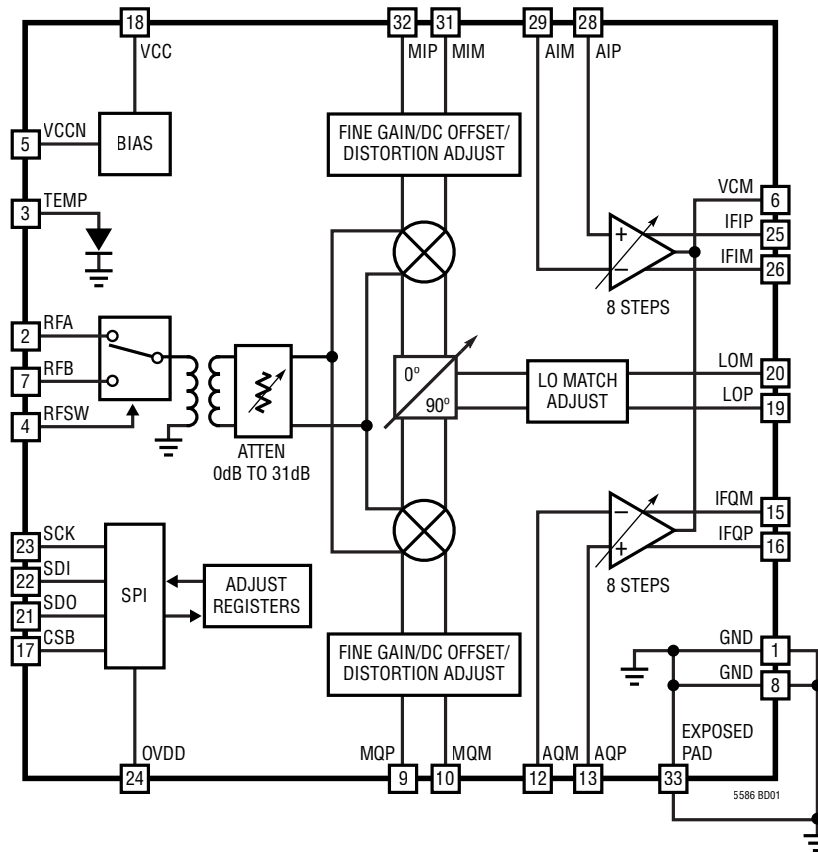
**SDI (Pins 22):** Serial Data Input. Data is clocked MSB first into the mode-control registers on the rising edge of SCK. SDI can be driven with 1.2V to 3.3V logic levels.

**SCK (Pin 23):** Serial Clock Input. SDI can be driven with 1.2V to 3.3V logic levels.

**OVDD (Pin 24):** Positive digital interface supply pin. This pin sets the logic levels for the digital interface. 1.2V to 3.3V can be used. This pin should be bypassed with a 1μF capacitor to ground. The VCC supply must be applied before the OVDD supply to prevent damage to the ESD diodes.

**GND (Pins 1, 8, Exposed Pad Pin 33):** Ground. These pins must be soldered to the circuit board RF ground plane. The backside exposed pad ground connection should have a low-inductance connection and good thermal contact to the printed circuit board ground plane using many through-hole vias. See layout information.

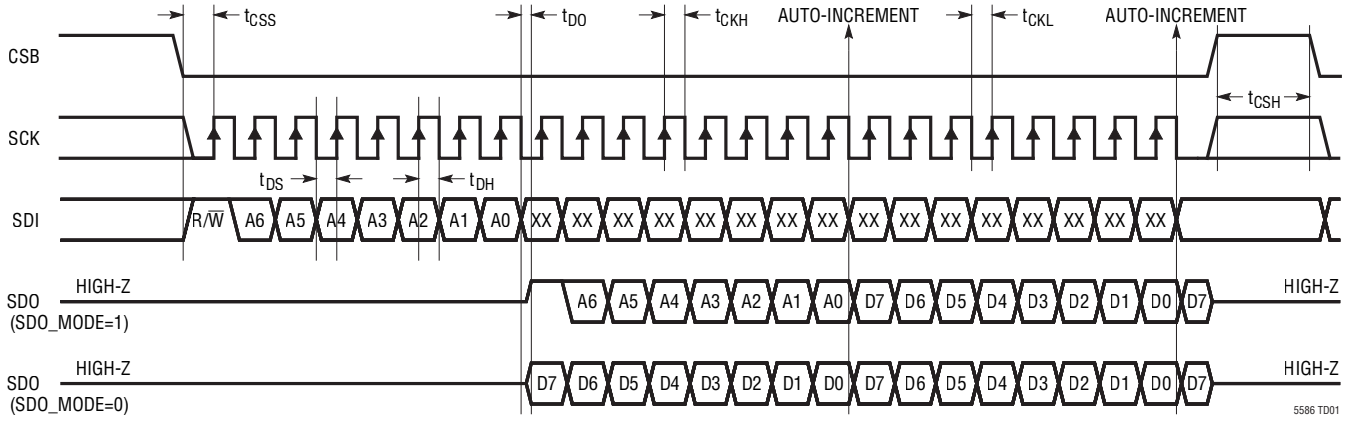
# BLOCK DIAGRAM





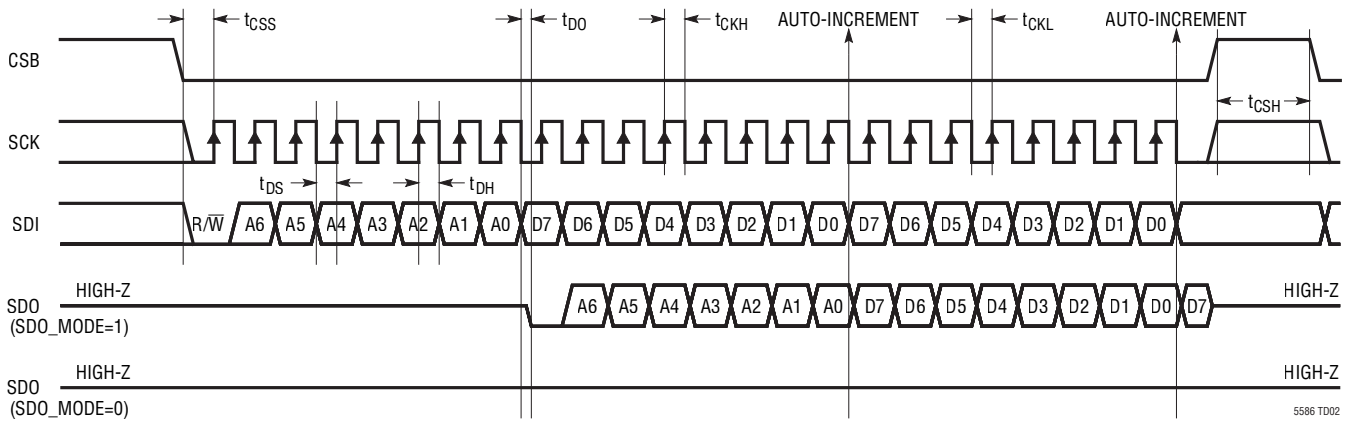
**TIMING DIAGRAMS**

**SPI Port Timing (Readback Mode)**



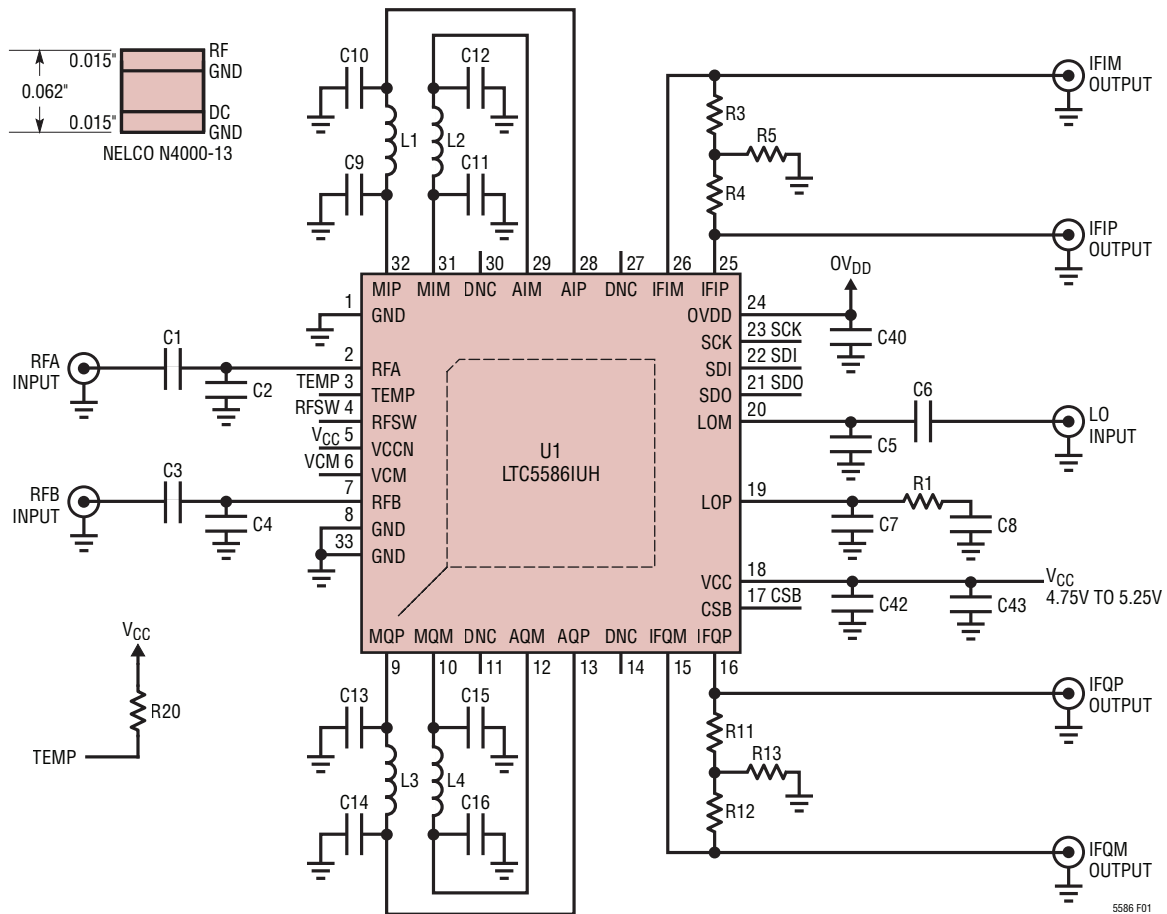
5586 TD01

**SPI Port Timing (Write Mode)**



5586 TD02

# TEST CIRCUIT



REF DES	VALUE	SIZE	VENDOR	REF DES	VALUE	SIZE	VENDOR
C1, C3, C6, C8, C42	1000pF	0402	Murata	L1-L4	22nH	0805	Coilcraft
C2, C4, C5, C7	0.3pF	0402	Murata	R1, R3, R4, R11, R12	49.9Ω	0402	
C9-C16	3.0pF	0201	Murata	R5, R13	0Ω	0402	
C40	1μF	0603	Murata	R20	40.2kΩ	0402	
C43	4.7μF	0805	Murata				

Figure 1. Test Circuit Schematic



## APPLICATIONS INFORMATION

The LTC5586 is an IQ demodulator designed for high dynamic range receiver applications. It consists of RF switches, a step attenuator, I/Q mixers, quadrature LO amplifiers, IF amplifiers, and correction circuitry for DC offset, image rejection, and non-linearity.

### Operation

As shown in the Block Diagram for the LTC5586, the RF inputs, RFA and RFB, are selected by an internal switch. The RF signal is then converted to a differential signal by the on-chip balun transformer covering the 300MHz to 6GHz band. A differential 0 to 31dB step attenuator then scales the RF input level to the I and Q channel mixers.

The LO inputs are impedance matched using a programmable network, and then accurately shifted in phase by 90° by an internal precision phase shifter. This phase shifter maintains the accurate quadrature relation over the full LO input range from 300MHz to 6GHz. In addition, the phase shifter allows fine tuning of the phase difference between the I- and Q-channel LO with a resolution of around 0.05 degrees to compensate for any phase mismatch between the mixers and phase mismatch introduced into the IF path by any filter component mismatch.

The differential mixer IF output signals are filtered off-chip to remove the  $f_{RF} + f_{LO}$  signal and other high frequency mixing products before being applied to the on-chip IF amplifiers. The IF amplifiers have adjustable gain and common-mode output voltage to allow for direct interfacing with A/D converters. The gain balance between both IF output channels of the LTC5586 can be fine tuned with

a resolution of about 0.016dB in order to compensate for gain mismatches in the IF signal path, either caused internally by the device or by external amplifiers and filters. The DC offset in both IF channels can be adjusted in order to minimize the accumulated DC offset at the A/D converter input.

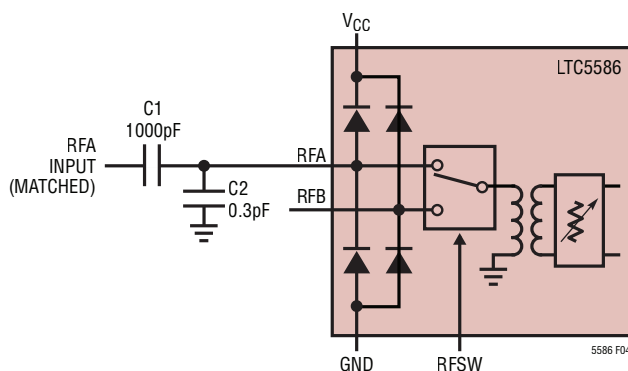
The RF switch state, attenuation, IF gain, gain error and phase error adjust, DC offset adjust, and non-linearity adjust registers are digitally controlled through a 4-wire SPI interface. The register map is detailed in the Appendix.

### RF Input Ports

Figure 4 shows a simplified schematic of the demodulator's RF inputs (the RFA input is identical to RFB input) which consist of an RF switch, balun transformer, and step-attenuator. External DC voltage should not be applied to the RF input pins. DC current flowing into the pins may cause damage to the chip. Series DC blocking capacitors should be used to couple the RF input pins to the RF signal sources. The RF switch can be selected by the RFSW pin, and by the RFSW register 0x17 bit[0]. The RFA input is selected when the logical AND of the value of RFSW in register 0x17 and the logic level of the RFSW pin is 1 (see digital input pins section and register map). The switch state is detailed in Table 1.

**Table 1. RF Switch State vs Logic Levels**

RFSW Register	RFSW Pin	
	0	1
0	RFB	RFB
1	RFB	RFA



**Figure 4. Simplified Schematic of the RF Input with External Matching Components**



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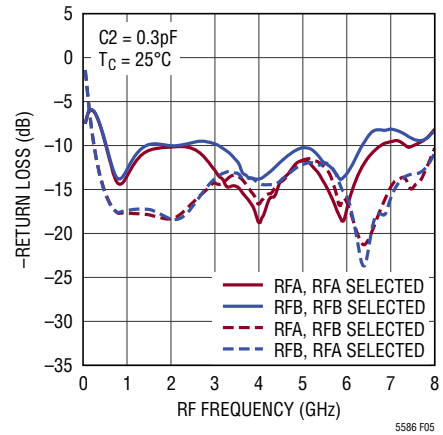
As shown in Figure 5, the RF input ports are well matched with return loss greater than 10dB over the frequency range of 500MHz to 6GHz with a 0.3pF capacitor on C2. The RF pins can be externally matched over the 300MHz to 500MHz frequency range by changing C2 to 4.7pF. Figure 6 shows the RF input return loss with C2 set to 4.7pF. Table 2 shows the impedance and input reflection coefficient for the RF input with C2 = 0.3pF. The input transmission line length is de-embedded from the measurement.

**Table 2. RF Input Impedance**

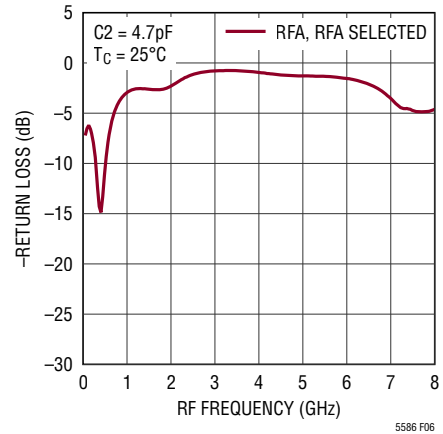
FREQUENCY (MHz)	INPUT IMPEDANCE ( $\Omega$ )	S11	
		MAG	ANGLE ( $^{\circ}$ )
300	24.9 + j27.6	0.468	112.0
400	39.1 + j37.3	0.403	83.5
500	60.1 + j36.9	0.330	56.2
700	77.4 - j1.9	0.215	-3.2
1000	43.7 - j19.2	0.211	-96.7
1500	27.2 - j2.1	0.297	-173.2
2000	29.6 + j14.5	0.310	134.4
2500	39.3 + j26.0	0.303	96.0
3000	48.9 + j23.1	0.228	79.9
3500	52.4 + j19.2	0.185	72.3
4000	60.5 + j8.2	0.120	33.8
4500	69.2 + j15.0	0.202	30.8
5000	82.4 + j11.5	0.259	14.6
5500	71.2 - j8.6	0.188	-18.0
6000	46.8 - j13.1	0.138	-96.1

### LO Input Port

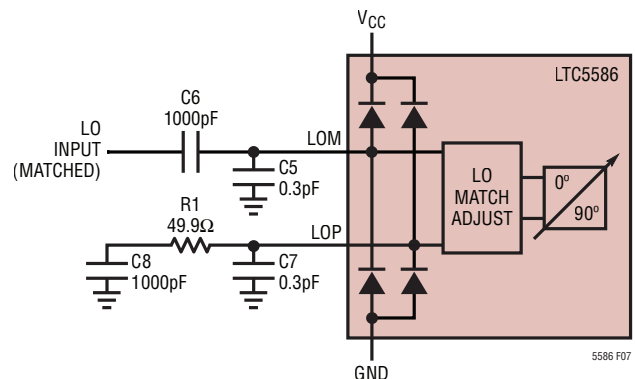
The demodulator's LO input interface is shown in Figure 7. The input consists of a programmable input match and a high precision quadrature phase shifter which generates 0° and 90° phase shifted LO signals for the LO buffer amplifiers to drive the I/Q mixers. DC blocking capacitors are required on the LOP and LOM inputs. When using a single-ended LO input, it is necessary to terminate the unused LO input (LOP in Figure 7) into 50 $\Omega$ .



**Figure 5. RF Input Return Loss**



**Figure 6. RF Input Return Loss with C2 = 4.7pF**



**Figure 7. Simplified Schematic of the LO Inputs with Single-Ended Drive**

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The programmable input match adjust is controlled by the BAND, CF1, LF1, and CF2 registers as detailed in the register map shown in Table 3. The return loss for the register setting in Table 3 is shown in Figure 8.

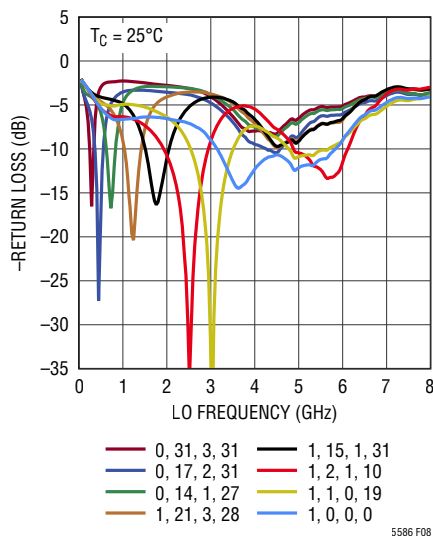


Figure 8. Single-Ended LO Input Return Loss vs BAND, CF1, LF1, and CF2

Table 3. Register Settings for Single-Ended LO Matching

LO FREQUENCY (MHz)	BAND	CF1	LF1	CF2
300 - 339	0	31	3	31
339 - 398	0	21	3	24
398 - 419	0	14	3	23
419 - 556	0	17	2	31
556 - 625	0	10	2	23
625 - 801	0	15	1	31
801 - 831	0	14	1	27
831 - 1046	0	8	1	21
1046 - 1242	1	31	3	31
1242 - 1411	1	21	3	28
1411 - 1696	1	17	2	26
1696 - 2070	1	15	1	31
2070 - 2470	1	8	1	21
2470 - 2980	1	2	1	10
2980 - 3500	1	1	0	19
3500 - 6000	1	0	0	0

The LO inputs can also be driven differentially. Figure 10 compares the uncalibrated OIP2 performance of single ended versus differential LO drive using the ANAREN B4859A53 balun as shown in the schematic of Figure 9.

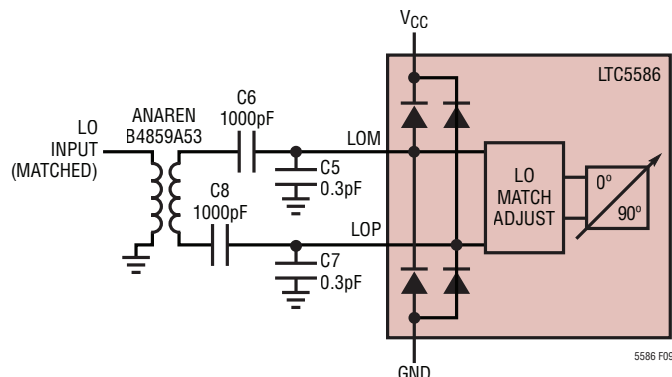


Figure 9. Simplified Schematic of the LO Inputs Using a Balun for Differential Drive

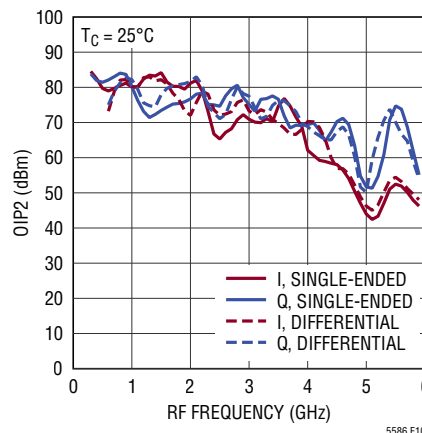


Figure 10. OIP2 vs Single-Ended and Differential LO Input

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### Interstage Filter

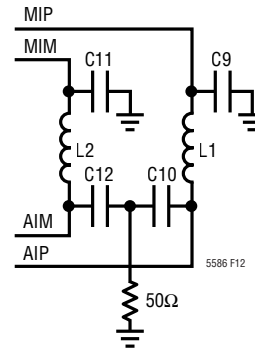
An interstage IF filter should be used between the MIP (MIM) and AIP (AIM) pins and the MQP (MQM) and AQP (AQM) pins to suppress the large  $f_{RF} + f_{LO}$  and other mixing products from the mixer outputs. Without the filter, the linearity of the amplifier can be degraded for the desired signal. Figure 11 shows a recommended lowpass filter. Table 4 shows typical values used for a lowpass response of various bandwidths.

**Table 4. Component Values for Interstage Lowpass Filter**

1dB BW (MHz)	L1, L2 (nH)	C9, C11 (pF)	C10, C12 (pF)
20	330	39	120
50	150	15	47
100	68	10	22
300	33	4.7	6.8
500	22	3.0	3.0
1000	8	0.5	1.0

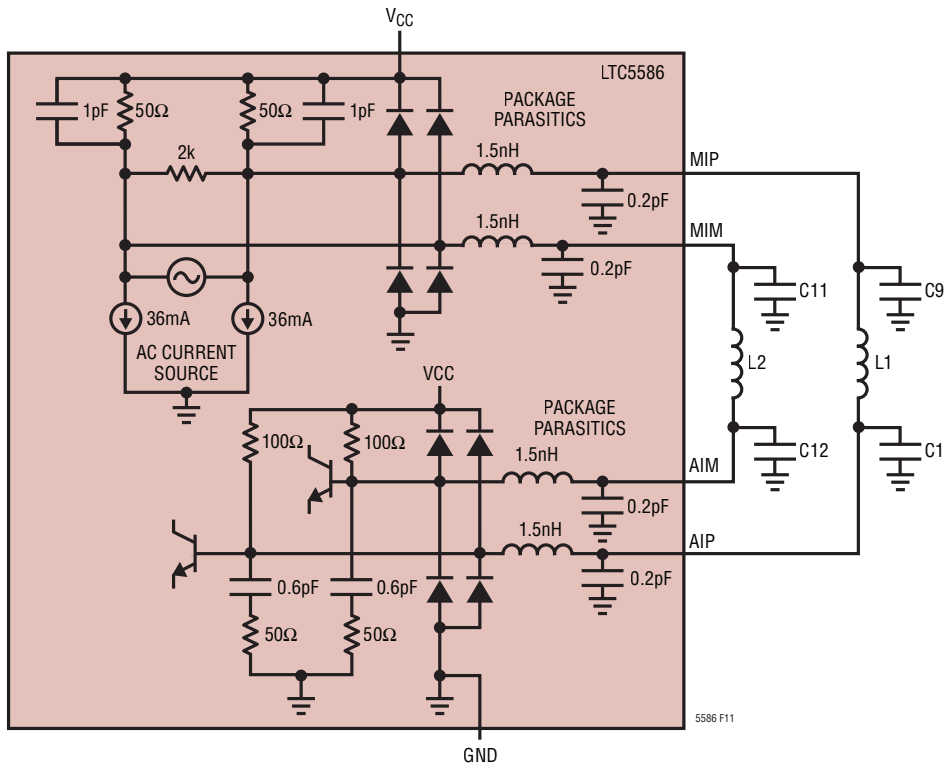
It is important that the placement of C10 and C12 be as close as possible to the amplifier inputs. Long line

lengths on the amplifier inputs can lead to instability. As shown in Figure 12, a 50Ω common-mode termination resistor can be used to better ensure stability with long line lengths and/or higher order filtering. The placement of C9 and C11 should be as close as possible to the mixer outputs for effective filtering of the  $2 \times f_{LO}$ ,  $f_{RF} + f_{LO}$ , and other mixing products.



**Figure 12. Interstage IF Filter with Common-Mode Termination**

By adjusting the values of the capacitors in the filter, it is possible to add or remove frequency slope of the IF



**Figure 11. Simplified Schematic of the Mixer Output and IF Amplifier Input with Interstage Filter**

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response. The RF input has a frequency slope above 2GHz of approximately  $-2\text{dB}/\text{GHz}$ . If a high-side LO (HSLO) is used the resulting IF slope will be  $2\text{dB}/\text{GHz}$ . If a low-side LO (LSLO) is used the resulting IF slope will be  $-2\text{dB}/\text{GHz}$ . The IF filter component values can be adjusted so that approximately 1dB of peaking or roll-off can be achieved over the filter bandwidth to give an overall flat IF response for the HSLO or LSLO case.

### I-Channel and Q-Channel Outputs

The phase relationship between the I-channel output signal and the Q-channel output signal is fixed. When the LO input frequency is higher (or lower) than the RF input frequency, the Q-channel outputs (IFQP, IFQM) lead (or lag) the I-channel outputs (IFIP, IFIM) by  $90^\circ$ .

Figure 14 shows a simplified schematic of the IF amplifier outputs. The current-mode outputs require a terminating resistance to establish a common-mode voltage level. The optimum operating current is 18mA per output. A  $50\Omega$  termination to ground is recommended on each output for a 0.9V common-mode voltage. Operation at higher or lower common-mode voltages is possible with the addition of a common-mode termination. For example, to operate at 1.8V, an additional common-mode resistance of  $25\Omega$  ( $R5 = 66.5\Omega$  and  $R6 = 0\Omega$ , or  $R5 = R6 = 43.2\Omega$ ) would be used to maintain an output current of 18mA. To operate

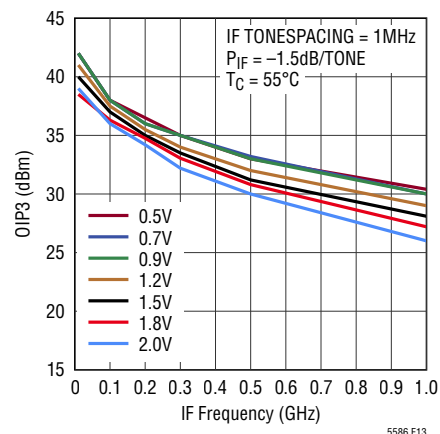


Figure 13. OIP3 of Amplifier Only vs Output Common-Mode Voltage (VCM)

at lower common-mode voltages, a lower termination resistance can be used on each output at the expense of conversion gain, or a negative supply can be used at the connection of the termination resistors. Figure 13 shows the OIP3 of the amplifier alone with various common-mode voltages.

The amplifier gain can be adjusted in 8 steps of roughly 1dB from 7dB to 15dB using the AMPG register. Setting  $\text{AMPG} = 0x7$  sets the gain at about 15dB and setting  $\text{AMPG} = 0x0$  sets the gain to about 7dB.

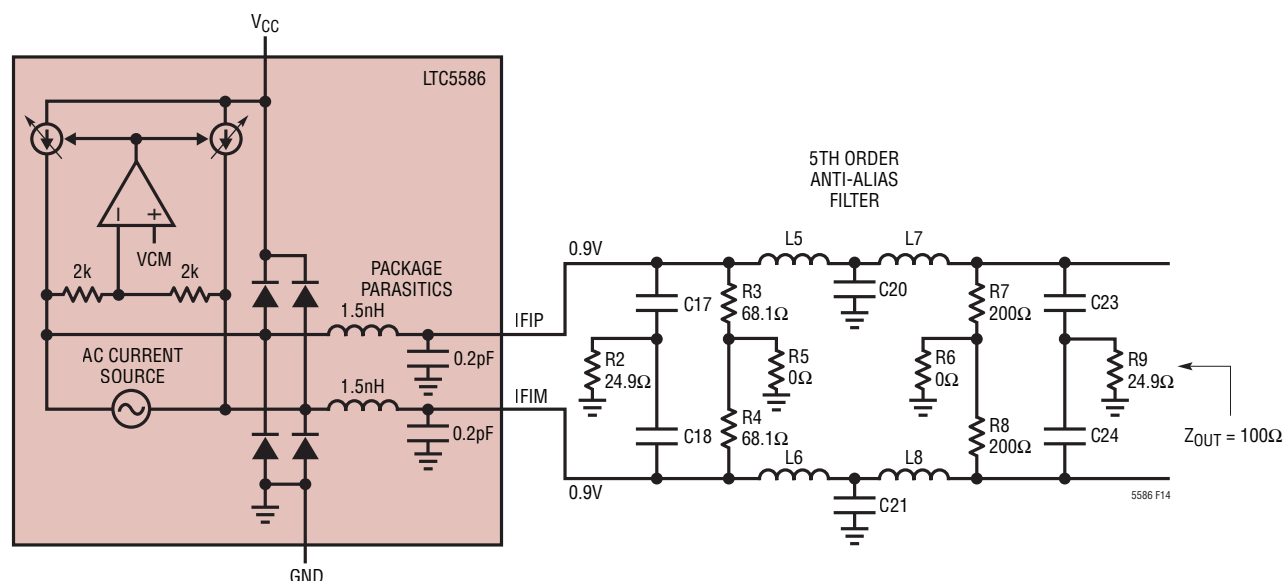


Figure 14. Simplified Schematic of the IF Amplifier Output with Anti-Alias Filter

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A typical anti-alias filter is shown in Figure 14 for interface with an ADC. The parallel combinations  $R3||R7$  and  $R4||R8$  set the differential impedance for the ADC. The input and output of the filter contain a common-mode termination for high frequencies. These are formed by  $C17$ ,  $C18$  and  $24.9\Omega$  at the input and  $C23$ ,  $C24$  and  $24.9\Omega$  at the output. The common-mode termination at the amplifier output ensures stability and the common-mode termination at the ADC input provides a termination for the high-frequency kickback from the sampling capacitors in the ADC. Table 5 shows some typical values vs 1dB cutoff frequency for the anti-alias filter. To optimize the flatness and ripple of the IF band, both the IF interstage filter and the anti-alias filter can be designed together in a simulator including package parasitics. The additional slope due to RF slope and HSLO or LSLO can be compensated by using this method. The layout of the anti-alias filter should be done so that the amplifier outputs and ADC inputs are as close as possible. This is to prevent long line lengths from introducing additional parasitics.

**Table 5. Component Values for Anti-Alias Lowpass Filter**

1dB BW (MHz)	L5 – L8 (nH)	C17, C18 (pF)	C20, C21 (pF)	C23, C24 (pF)
20	560	56	180	82
50	240	22	68	33
100	120	12	39	22
300	33	3.9	8.2	6.8
500	22	1.8	6.8	3.3
1000	8	1.0	3.3	1.8

Tables 6 and 7 show the differential and common-mode S-parameters for the amplifier by itself with  $50\Omega$  terminations on all ports. In addition, common-mode terminations were used on the input and output ports having a value of  $2pF$  in series with  $50\Omega$ .

**Table 6. IF Amplifier S-Parameters (Differential-Mode)**

IF (MHz)	S <sub>11</sub>		S <sub>21</sub>		S <sub>12</sub>		S <sub>22</sub>	
	MAG	ANG	MAG	ANG	MAG	ANG	MAG	ANG
0.001	0.204	-179.9	2.129	180.0	1.8e-4	164.8	0.014	178.5
100	0.203	176.0	2.154	171.9	5.4e-4	118.0	0.026	-120.9
200	0.205	172.2	2.170	163.7	1.0e-4	102.8	0.050	-112.0
300	0.207	168.5	2.197	155.6	1.7e-4	92.8	0.079	-113.5
400	0.210	164.8	2.239	147.3	2.8e-4	93.7	0.111	-118.3
500	0.215	160.9	2.292	138.8	3.2e-4	95.4	0.147	-125.0
600	0.221	157.0	2.363	130.1	4.0e-4	92.0	0.186	-132.1
700	0.227	153.0	2.445	121.2	5.0e-4	92.1	0.230	-140.0
800	0.235	149.0	2.535	112.0	5.5e-4	86.2	0.279	-148.1
900	0.242	144.6	2.642	102.0	6.9e-4	93.2	0.334	-157.0
1000	0.251	140.6	2.770	92.3	7.9e-4	92.7	0.396	-166.2
1500	0.303	117.6	3.420	32.3	0.003	92.6	0.738	134.4
2000	0.365	90.2	3.318	-45.5	0.005	33.2	0.828	70.0
2500	0.385	56.1	2.232	-105.2	0.005	-3.1	0.666	13.1
3000	0.365	16.6	2.620	-160.2	0.005	-34.2	0.488	-38.4
3500	0.319	-28.2	1.021	157.4	0.005	-61.9	0.418	-94.7
4000	0.307	-83.4	0.742	113.3	0.005	-79.5	0.409	-150.6

**Table 7. IF Amplifier S-Parameters (Common-Mode)**

IF (MHz)	S <sub>11</sub>		S <sub>21</sub>		S <sub>12</sub>		S <sub>22</sub>	
	MAG	ANG	MAG	ANG	MAG	ANG	MAG	ANG
0.001	0.184	-138.7	9.2e-4	-112.8	0.037	-65.3	0.985	179.8
100	0.186	172.5	0.085	-118.9	0.013	-68.6	0.152	126.7
200	0.188	166.6	0.173	-134.7	0.007	-91.8	0.125	116.7
300	0.191	160.2	0.237	-150.0	0.004	-113.1	0.097	97.3
400	0.196	154.4	0.291	-163.8	0.002	-145.4	0.067	75.2
500	0.202	148.4	0.340	-176.8	0.002	170.2	0.037	43.6
600	0.210	142.8	0.387	170.9	0.002	137.0	0.023	-38.0
700	0.219	137.2	0.436	159.1	0.003	118.1	0.051	-97.8
800	0.230	132.0	0.488	147.1	0.003	107.8	0.094	-121.5
900	0.243	126.5	0.550	134.9	0.004	106.6	0.148	-137.0
1000	0.252	120.9	0.612	122.2	0.006	104.8	0.211	-151.3
1500	0.325	96.7	0.981	43.4	0.020	80.4	0.749	136.1
2000	0.438	72.1	0.776	-46.1	0.036	18.6	1.000	55.9
2500	0.549	40.1	0.496	-97.1	0.041	-21.9	0.873	2.9
3000	0.601	6.9	0.397	-143.2	0.042	-52.2	0.764	-37.3
3500	0.618	-27.5	0.281	-175.7	0.044	-80.3	0.668	-72.7
4000	0.595	-60.3	0.254	147.3	0.046	-101.2	0.620	-107.0

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The common-mode feedback amplifier holds the common-mode output voltage within about 20mV of the VCM pin voltage. The VCM pin interface is shown in Figure 15. The VCM pin should be driven by a voltage source with an output impedance lower than 1k $\Omega$ . When the VCM pin is unbiased, the output common-mode voltage will be held at a nominal 0.9V given by the internal voltage divider formed by the 40k $\Omega$  and 8k $\Omega$  resistors. Connecting the VCM pin to an ADC common-mode reference pin allows

the output common-mode voltage of the IF amplifier to track the ADC common-mode.

### Temperature Diode

A schematic of the TEMP pin is shown in Figure 16. The temperature diode can be used to directly measure the die temperature. A 40k $\Omega$  resistor is recommended to  $V_{CC}$  to generate a 100 $\mu$ A current source for the diode readout. The temperature slope is about  $-1.52\text{mV}/^\circ\text{C}$ .

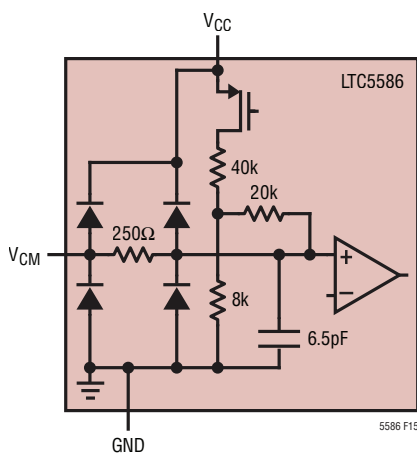


Figure 15. Simplified Schematic of the VCM Input Pin

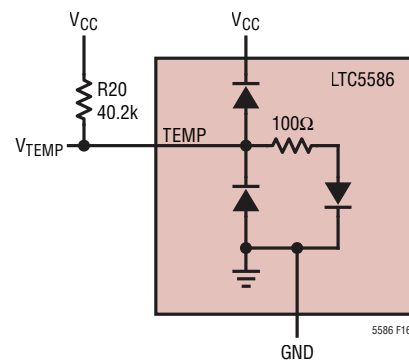


Figure 16. Schematic of the TEMP Pin